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#### ADS54J20

SBAS766B - MAY 2016 - REVISED JANUARY 2017

# ADS54J20 Dual-Channel, 12-Bit, 1.0-GSPS, Analog-to-Digital Converter

Technical

Documents

## 1 Features

- 12-Bit Resolution, Dual-Channel, 1-GSPS ADC
- Noise Floor: -157 dBFS/Hz
- Spectral Performance (f<sub>IN</sub> = 170 MHz at -1 dBFS):
  - SNR: 67.8 dBFS
  - NSD: -155 dBFS/Hz
  - SFDR: 86 dBc (Including Interleaving Tones)
  - SFDR: 89 dBc (Except HD2, HD3, and Interleaving Tones)
- Spectral Performance (f<sub>IN</sub> = 350 MHz at -1 dBFS):
  - SNR: 65.6 dBFS
  - NSD: –152.6 dBFS/Hz
  - SFDR: 75 dBc
  - SFDR: 85 dBc (Except HD2, HD3, and Interleaving Tones)
- Channel Isolation: 100 dBc at f<sub>IN</sub> = 170 MHz
- Input Full-Scale: 1.9 V<sub>PP</sub>
- Input Bandwidth (3 dB): 1.2 GHz
- On-Chip Dither
- Integrated Wideband DDC Block
- JESD204B Interface with Subclass 1 Support:
  - 2 Lanes per ADC at 10.0 Gbps
  - 4 Lanes per ADC at 5.0 Gbps
  - Support for Multi-Chip Synchronization
- Power Dissipation: 1.35 W/Ch at 1 GSPS
- Package: 72-Pin VQFNP (10 mm × 10 mm)

## 2 Applications

- Radar and Antenna Arrays
- Broadband Wireless
- Cable CMTS, DOCSIS 3.1 Receivers
- Communications Test Equipment
- Microwave Receivers
- Software Defined Radios (SDRs)
- Digitizers
- Medical Imaging and Diagnostics

## 3 Description

Tools &

Software

The ADS54J20 is a low-power, wide-bandwidth, 12-1.0-GSPS. dual-channel, analog-to-digital bit. converter (ADC). Designed for high signal-to-noise ratio (SNR), the device delivers a noise floor of -157 dBFS/Hz for applications aiming for highest dynamic range over a wide instantaneous bandwidth. The device supports the JESD204B serial interface with data rates up to 10 Gbps, supporting two or four lanes per ADC. The buffered analog input provides uniform input impedance across a wide frequency range and minimizes sample-and-hold glitch energy. Optionally, each ADC channel can be connected to a wideband digital down-converter (DDC) block. The ADS54J20 provides excellent spurious-free dynamic range (SFDR) over a large input frequency range with very low power consumption.

Support &

Community

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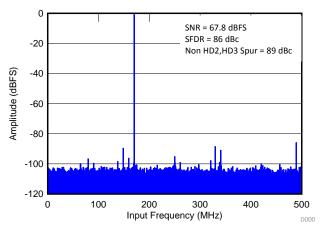
The JESD204B interface reduces the number of interface lines, allowing high system integration density. An internal phase-locked loop (PLL) multiplies the ADC sampling clock to derive the bit clock that is used to serialize the 12-bit data from each channel.

#### **Device Information**

PART NUMBER	PACKAGE	BODY SIZE (NOM)		
ADS54J20	VQFNP (72)	10.00 mm × 10.00 mm		

(1) For all available packages, see the orderable addendum at the end of the data sheet.

## FFT for 170-MHz Input Signal



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# 4 Revision History

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NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

## Changes from Revision A (May 2016) to Revision B

•	Changed the Device Comparison Table	3
•	Added the FOVR latency parameter to the Timing Characteristics table	. 12
•	Added SYSREF Not Present (Subclass 0, 2) section	. 30
•	Changed the number of clock cycles in the Fast OVR section	. 31
•	Changed the Register Map	. 45
•	Deleted register 39h, 3Ah, and 56h	. 45
•	Changed Power Supply Recommendations section	. 75
•	Added the Power Sequencing and Initialization section	. 76
•	Added the Receiving Notification of Documentation Updates section	. 79

#### Changes from Original (May 2016) to Revision A

Released to production	1
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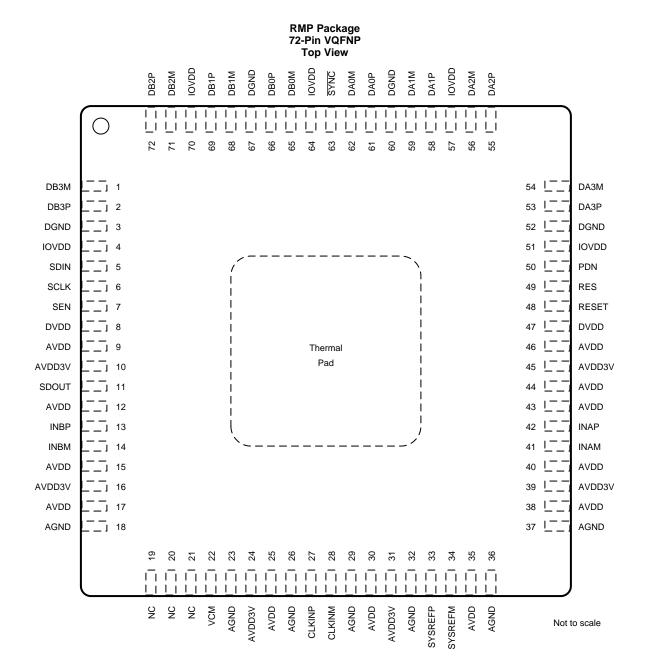
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Page

## 5 Device Comparison Table

PART NUMBER	SPEED GRADE (MSPS)	<b>RESOLUTION (Bits)</b>	CHANNEL
ADS54J20	1000	12	2
ADS54J42	625	14	2
ADS54J40	1000	14	2
ADS54J60	1000	16	2
ADS54J66	500	14	4
ADS54J69	500	16	2

# 6 Pin Configuration and Functions



ADS54J20

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Pin Functions					
	PIN	I/O	DESCRIPTION		
NAME	NO.				
CLOCK, SYS					
CLKINM	28		Negative differential clock input for the ADC		
CLKINP	27		Positive differential clock input for the ADC		
SYSREFM	34		Negative external SYSREF input		
SYSREFP	33	I	Positive external SYSREF input		
CONTROL, S	SERIAL				
PDN	50	I/O	Power-down. Can be configured via an SPI register setting. Can be configured as a fast overrange output for channel A via the SPI.		
RESET	48	Ι	Hardware reset; active high. This pin has an internal 20-k $\Omega$ pulldown resistor.		
SCLK	6	Ι	Serial interface clock input		
SDIN	5	Ι	Serial interface data input		
SDOUT	11	0	Serial interface data output. Can be configured as a fast overrange output for channel B via the SPI.		
SEN	7	-	Serial interface enable		
DATA INTER	FACE				
DA0M	62	0			
DA1M	59	0			
DA2M	56	0	JESD204B serial data negative output for channel A		
DA3M	54	0	_		
DA0P	61	0			
DA1P	58	0			
DA2P	55	0	JESD204B serial data positive output for channel A		
DA3P	53	0			
DB0M	65	0			
DB1M	68	0			
DB2M	71	0	JESD204B serial data negative output for channel B		
DB3M	1	0			
DB0P	66	0			
DB1P	69	0			
DB2P	72	0	JESD204B serial data positive output for channel B		
DB3P	2	0	_		
SYNC	63	Ι	Synchronization input for the JESD204B port		
INPUT, COM	MON MODE				
INAM	41	I	Differential analog negative input for channel A		
INAP	42	-	Differential analog positive input for channel A		
INBM	14	Ι	Differential analog negative input for channel B		
INBP	13	Ι	Differential analog positive input for channel B		
VCM	22	0	Common-mode voltage, 2.1 V. Note that analog inputs are internally biased to this pin through 600 $\Omega$ (effective), no external connection from the VCM pin to the INxP or INxM pin is required.		
POWER SUP	PPLY		·		
AGND	18, 23, 26, 29, 32, 36, 37	I	Analog ground		
AVDD	9, 12, 15, 17, 25, 30, 35, 38, 40, 43, 44, 46	Ι	Analog 1.9-V power supply		
AVDD3V	10, 16, 24, 31, 39, 45	I	Analog 3.0-V power supply for the analog buffer		
DGND	3, 52, 60, 67	Ι	Digital ground		
DVDD	8, 47	-	Digital 1.9-V power supply		
IOVDD	4, 51, 57, 64, 70		Digital 1.15-V power supply for the JESD204B transmitter		
NC, RES	, - , - · , <del>-</del> · , · <del>-</del>		· · · · · · · · · · · · · · · · · · ·		
NC	19, 20, 21	_	Unused pin, do not connect		
RES	49	I	Reserved pin. Connect to DGND.		



## 7 Specifications

## 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
	AVDD3V	-0.3	3.6	
Supply voltage range Voltage between AGND and E	AVDD	-0.3	2.1	V
Supply vollage lange	DVDD	-0.3	2.1	v
Voltage between AGND and I	IOVDD	-0.2	1.4	
/oltage between AGND and DGND		-0.3	0.3	V
Nelle and a leader to the second second	INAP, INBP, INAM, INBM	-0.3	3	
	CLKINP, CLKINM	-0.3	AVDD + 0.3	V
Voltage applied to input pins	SYSREFP, SYSREFM	-0.3	AVDD + 0.3	v
	SCLK, SEN, SDIN, RESET, SYNC, PDN	-0.2	2.1	
Storage temperature, T <sub>stg</sub>		-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## 7.2 ESD Ratings

			VALUE	UNIT
	Electrostatia discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±1000	V
V(ESD)	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup>	±500	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V HBM allows safe manufacturing with a standard ESD control process.

**STRUMENTS** 

EXAS

## 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)(2)</sup>

			MIN	NOM	MAX	UNIT	
	AVDD3V		2.85	3.0	3.6		
	AVDD		1.8	1.9	2.0	V	
Supply voltage range	DVDD		1.7	1.9	2.0	v	
	IOVDD		1.1	1.15	1.2		
	Differential input voltage range			1.9		V <sub>PP</sub>	
Analog inputs	Input common-mode voltage			2.0		V	
	Maximum analog input frequency for a 1.9-V <sub>PP</sub> input amplitude <sup>(3)(4)</sup>			400		MHz	
	Input clock frequency, device clock	k frequency	250 <sup>(5)</sup>		1000	MHz	
		Sine wave, ac-coupled	0.75	1.5			
Clock inputs	Input clock amplitude differential (V <sub>CLKP</sub> – V <sub>CLKM</sub> )	LVPECL, ac-coupled	0.8	1.6		V <sub>PP</sub>	
		LVDS, ac-coupled		0.7			
	Input device clock duty cycle		45%	50%	55%		
Tama anatuna	Operating free-air, T <sub>A</sub>		-40		85		
Temperature	Operating junction, T <sub>J</sub>			105 <sup>(6)</sup>	125	°C	

(1) SYSREF must be applied for the device to initialize; see the SYSREF Signal section for details.

(2) After power-up, always use a hardware reset to reset the device for the first time; see Table 65 for details.

(3) Operating 0.5 dB below the maximum-supported amplitude is recommended to accommodate gain mismatch in interleaving ADCs.

(4) At high frequencies, the maximum supported input amplitude reduces; see Figure 36 for details.

(5) See Table 10 and Table 12.

(6) Prolonged use above the nominal junction temperature can increase the device failure-in-time (FIT) rate.

## 7.4 Thermal Information

		ADS54J20	
	THERMAL METRIC <sup>(1)</sup>	RMP (VQFNP)	UNIT
		72 PINS	
$R_{\thetaJA}$	Junction-to-ambient thermal resistance	22.3	°C/W
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	5.1	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	2.4	°C/W
ΨJT	Junction-to-top characterization parameter	0.1	°C/W
ΨЈВ	Junction-to-board characterization parameter	2.3	°C/W
R <sub>0JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	0.4	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.



## 7.5 Electrical Characteristics

typical values are at  $T_A = 25^{\circ}$ C, full temperature range is from  $T_{MIN} = -40^{\circ}$ C to  $T_{MAX} = +85^{\circ}$ C, ADC sampling rate = 1.0 GSPS, 50% clock duty cycle, AVDD3V = 3.0 V, AVDD = DVDD = 1.9 V, IOVDD = 1.15 V, -1-dBFS differential input, and 0-dB digital gain (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
GENERAL						
	ADC sampling rate				1000	MSPS
	Resolution		12			Bits
POWER SUI	PPLIES				i.	
AVDD3V	3.0-V analog supply		2.85	3.0	3.6	V
AVDD	1.9-V analog supply		1.8	1.9	2.0	V
DVDD	1.9-V digital supply		1.7	1.9	2.0	V
IOVDD	1.15-V SerDes supply		1.1	1.15	1.2	V
I <sub>AVDD3V</sub>	3.0-V analog supply current	V <sub>IN</sub> = full-scale on both channels		334	360	mA
I <sub>AVDD</sub>	1.9-V analog supply current	V <sub>IN</sub> = full-scale on both channels		359	510	mA
		8 lanes active (LMFS = 8224)		197	260	mA
I <sub>DVDD</sub>	1.9-V digital supply current	4 lanes active (LMFS = 4222), 2X decimation		197		mA
		2 lanes active (LMFS = 2221), 4X decimation		176		mA
		8 lanes active (LMFS = 8224)		566	920	mA
IIOVDD	1.15-V SerDes supply current	4 lanes active (LMFS = 4222), 2X decimation		593		mA
		2 lanes active (LMFS = 2221), 4X decimation		562		mA
		8 lanes active (LMFS = 8224)		2.71	3.1	W
P <sub>D</sub>	Total power dissipation <sup>(1)</sup>	4 lanes active (LMFS = 4222), 2X decimation		2.74		W
		2 lanes active (LMFS = 2221), 4X decimation		2.66		W
	Global power-down power dissipation			139	315	mW
ANALOG IN	IPUTS (INAP, INAM, INBP, INBM)					
	Differential input full-scale voltage			1.9		$V_{PP}$
V <sub>IC</sub>	Common-mode input voltage			2.0		V
R <sub>IN</sub>	Differential input resistance	At 170-MHz input frequency		0.6		kΩ
C <sub>IN</sub>	Differential input capacitance	At 170-MHz input frequency		4.7		pF
	Analog input bandwidth (3 dB)	50- $\Omega$ source driving ADC inputs terminated with 50 $\Omega$		1.2		GHz
	UT (CLKINP, CLKINM)				L	
	Internal clock biasing	CLKINP and CLKINM are connected to internal biasing voltage through 400 $\Omega$		1.15		V

(1) See the *Power-Down Mode* section for details.

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## 7.6 AC Characteristics

typical values are at  $T_A = 25^{\circ}$ C, full temperature range is from  $T_{MIN} = -40^{\circ}$ C to  $T_{MAX} = +85^{\circ}$ C, ADC sampling rate = 1.0 GSPS, 50% clock duty cycle, AVDD3V = 3.0 V, AVDD = DVDD = 1.9 V, IOVDD = 1.15 V, -1-dBFS differential input amplitude, and 0-dB digital gain (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP MA	X UNIT	
		$f_{IN} = 10 \text{ MHz}, A$	A <sub>IN</sub> = -1 dBFS		68.4		
		$f_{IN} = 100 \text{ MHz},$	$A_{IN} = -1 \text{ dBFS}$		68.3		
		f <sub>IN</sub> = 170 MHz,	$A_{IN} = -1 \text{ dBFS}$	64	67.8		
		f <sub>IN</sub> = 230 MHz,	$A_{IN} = -1 \text{ dBFS}$		67.4		
	O'ment to main a matin	f <sub>IN</sub> = 270 MHz,	$A_{IN} = -1 \text{ dBFS}$		67.0		
SNR	Signal-to-noise ratio	$f_{IN} = 300 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$			66.7	dBFS	
		f <sub>IN</sub> = 370 MHz,	A <sub>IN</sub> = -1 dBFS		65.8		
		f <sub>IN</sub> = 470 MHz,	$A_{IN} = -3 \text{ dBFS}$		66.3		
		( <b>7</b> 00 MIL	$A_{IN} = -6 \text{ dBFS}$		65.5		
		f <sub>IN</sub> = 720 MHz	$A_{IN} = -6 \text{ dBFS}$ , gain = 5 dB		61.5		
		$f_{IN} = 10 \text{ MHz}, A$	A <sub>IN</sub> = -1 dBFS		155.4		
		$f_{IN} = 100 \text{ MHz},$	A <sub>IN</sub> = -1 dBFS		155.3		
		f <sub>IN</sub> = 170 MHz,	A <sub>IN</sub> = -1 dBFS	151	154.8		
		f <sub>IN</sub> = 230 MHz,	A <sub>IN</sub> = -1 dBFS		154.4		
	Noise spectral density	f <sub>IN</sub> = 270 MHz,	$A_{IN} = -1 \text{ dBFS}$		154.0		
NSD		f <sub>IN</sub> = 300 MHz,	$A_{IN} = -1 \text{ dBFS}$		153.7	dBFS/Hz	
		f <sub>IN</sub> = 370 MHz,	A <sub>IN</sub> = -1 dBFS		152.8		
		f <sub>IN</sub> = 470 MHz,	A <sub>IN</sub> = -3 dBFS		153.3		
		f <sub>IN</sub> = 720 MHz	$A_{IN} = -6 \text{ dBFS}$		152.5		
			$A_{IN} = -6 \text{ dBFS}$ , gain = 5 dB		148.5		
		f <sub>IN</sub> = 10 MHz, A	A <sub>IN</sub> = –1 dBFS		68.3		
		$f_{IN} = 100 \text{ MHz},$	A <sub>IN</sub> = -1 dBFS		68.1		
		f <sub>IN</sub> = 170 MHz,	A <sub>IN</sub> = -1 dBFS	63.2	67.7		
		f <sub>IN</sub> = 230 MHz,	A <sub>IN</sub> = -1 dBFS		67.2		
0.0.10	Signal-to-noise and	f <sub>IN</sub> = 270 MHz,	A <sub>IN</sub> = -1 dBFS		66.7	10.50	
SINAD	distortion ratio	f <sub>IN</sub> = 300 MHz,	A <sub>IN</sub> = -1 dBFS		66.3	dBFS	
		f <sub>IN</sub> = 370 MHz,	A <sub>IN</sub> = -1 dBFS		65.0		
		f <sub>IN</sub> = 470 MHz,	$A_{IN} = -3 \text{ dBFS}$		65.7		
			$A_{IN} = -6 \text{ dBFS}$		64.7		
	f <sub>ll</sub>	$f_{IN} = 720 \text{ MHz}$	$A_{IN} = -6 \text{ dBFS}$ , gain = 5 dB		60.8		
		f <sub>IN</sub> = 10 MHz, A	A <sub>IN</sub> = –1 dBFS		85.0		
		f <sub>IN</sub> = 100 MHz,			83.0		
			A <sub>IN</sub> = -1 dBFS	74	86.0		
		f <sub>IN</sub> = 230 MHz,			85.0		
0555	Spurious-free dynamic range	f <sub>IN</sub> = 270 MHz,	$A_{IN} = -1 \text{ dBFS}$		81.0		
SFDR	(excluding IL spurs)	$f_{IN} = 300 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$			78.0	dBc	
		f <sub>IN</sub> = 370 MHz,			73.0		
		f <sub>IN</sub> = 470 MHz,			72.0		
			$A_{IN} = -6 \text{ dBFS}$		68.0	1	
			$f_{IN} = 720 \text{ MHz}$ $A_{IN} = -6 \text{ dBFS}, \text{ gain} = 5 \text{ dB}$		69.0		

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## AC Characteristics (continued)

	PARAMETER	TEST CONDITIONS	MIN	TYP MAX	UNIT
		$f_{IN}$ = 10 MHz, $A_{IN}$ = -1 dBFS		85.0	
		$f_{IN} = 100 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		90.0	
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	74	92.0	
		$f_{IN} = 230 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		85.0	
	Second-order harmonic	$f_{IN} = 270 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		81.0	dDa
HD2	distortion	$f_{IN} = 300 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		81.0	dBc
		$f_{IN} = 370 \text{ MHz}, \text{ A}_{IN} = -1 \text{ dBFS}$		76.0	
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		72.0	
		$A_{IN} = -6 \text{ dBFS}$		68.0	
		$f_{IN} = 720 \text{ MHz} \qquad \begin{array}{c} 74_{IN} = 0.021 \text{ G} \\ A_{IN} = -6 \text{ dBFS, gain} = 5 \text{ dB} \end{array}$		69.0	
		$f_{IN} = 10 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		85.0	
		$f_{IN} = 100 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		83.0	
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	74	86.0	
	Third-order harmonic distortion	$f_{IN} = 230 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		87.0	
		f <sub>IN</sub> = 270 MHz, A <sub>IN</sub> = -1 dBFS		81.0	5
HD3		$f_{IN} = 300 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		78.0	dBc
		f <sub>IN</sub> = 370 MHz, A <sub>IN</sub> = -1 dBFS		73.0	
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		70.0	
		$A_{IN} = -6 \text{ dBFS}$		77.0	
		$f_{IN} = 720 \text{ MHz} \qquad \begin{array}{c} 74_{IN} = 0.021 \text{ G} \\ \hline A_{IN} = -6 \text{ dBFS, gain} = 5 \text{ dB} \end{array}$		79.0	
		$f_{IN} = 10 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		94.0	
		$f_{IN} = 100 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		97.0	
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	77	93.0	l.
		$f_{IN} = 230 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		95.0	
Non	Spurious-free dynamic range	$f_{IN} = 270 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		95.0	
HD2, HD3	(excluding HD2, HD3, and IL spur)	$f_{IN} = 300 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		91.0	dBFS
-		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		85.0	
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		88.0	
		$A_{\rm IN} = -6  \rm dBFS$		80.0	
l		$f_{IN} = 720 \text{ MHz} \qquad \begin{array}{c} 74_{IN} = 0.021 \text{ G} \\ \hline A_{IN} = -6 \text{ dBFS, gain} = 5 \text{ dB} \end{array}$		83.0	
		$f_{IN} = 10 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		11.1	
		$f_{IN} = 100 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		11.0	
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	10.2	11.0	
		$f_{IN} = 230 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		10.9	
ENICE		f <sub>IN</sub> = 270 MHz, A <sub>IN</sub> = -1 dBFS		10.8	<b>D</b>
ENOB	Effective number of bits	f <sub>IN</sub> = 300 MHz, A <sub>IN</sub> = -1 dBFS		10.7	Bits
		f <sub>IN</sub> = 370 MHz, A <sub>IN</sub> = -1 dBFS		10.5	
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		10.6	
				10.5	
l		$f_{IN} = 720 \text{ MHz} \qquad \frac{A_{IN} = -6 \text{ dBFS}}{A_{IN} = -6 \text{ dBFS}, \text{ gain} = 5 \text{ dB}}$		9.8	

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## AC Characteristics (continued)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
	$f_{IN} = 10 \text{ MHz}, A$	A <sub>IN</sub> = -1 dBFS		82.0			
	$f_{IN} = 100 \text{ MHz},$	$A_{IN} = -1 \text{ dBFS}$		80.0			
	f <sub>IN</sub> = 170 MHz,	$A_{IN} = -1 \text{ dBFS}$	72	83.0			
	f <sub>IN</sub> = 230 MHz, A <sub>IN</sub> = -1 dBFS			82.0			
Total harmonia distortion	$f_{IN} = 270 \text{ MHz},$	$A_{IN} = -1 \text{ dBFS}$		78.0		dPo	
Total harmonic distortion	$f_{IN} = 300 \text{ MHz},$	$A_{IN} = -1 \text{ dBFS}$		75.0		dBc	
	f <sub>IN</sub> = 370 MHz,	$A_{IN} = -1 \text{ dBFS}$		70.0			
	f <sub>IN</sub> = 470 MHz,	$A_{IN} = -3 \text{ dBFS}$		71.0			
	f 700 MU	$A_{IN} = -6 \text{ dBFS}$		67.0			
	$I_{\rm IN} = 720$ IVIAZ	$A_{IN} = -6 \text{ dBFS}$ , gain = 5 dB		69.0			
<ul> <li>Interleaving spur</li> </ul>	$f_{IN} = 10 \text{ MHz}, A$	$A_{\rm IN} = -1  \rm dBFS$		84.0			
	$f_{IN} = 100 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$			85.0			
	f <sub>IN</sub> = 170 MHz,	$A_{IN} = -1 \text{ dBFS}$	69	84.0			
	$f_{IN} = 230 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$			83.0		dBc	
	$f_{IN} = 270 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		82.0				
	$f_{IN} = 300 \text{ MHz},$	$A_{IN} = -1 \text{ dBFS}$		81.0		авс	
	f <sub>IN</sub> = 370 MHz,	$A_{IN} = -1 \text{ dBFS}$		81.0			
	f <sub>IN</sub> = 470 MHz,	$A_{IN} = -3 \text{ dBFS}$		78.0			
	f 700 MU	$A_{IN} = -6 \text{ dBFS}$		79.0			
	$f_{IN} = 720 \text{ MHz}$	$A_{IN} = -6 \text{ dBFS}, \text{ gain} = 5 \text{ dB}$		82.0			
Two-tone, third-order intermodulation distortion	$f_{IN1} = 185 \text{ MHz}$ $A_{IN} = -7 \text{ dBFS}$	, f <sub>IN2</sub> = 190 MHz,		85			
				79		dBFS	
				75			
Crosstalk isolation between channel A and B		0 00		100		dB	
	Total harmonic distortion Interleaving spur Two-tone, third-order intermodulation distortion Crosstalk isolation between	$\label{eq:result} Total harmonic distortion \\ \hline f_{IN} = 10 \ MHz, \ A \\ f_{IN} = 100 \ MHz, \ A \\ f_{IN} = 100 \ MHz, \ A \\ f_{IN} = 230 \ MHz, \ A \\ f_{IN} = 230 \ MHz, \ A \\ f_{IN} = 300 \ MHz, \ A \\ f_{IN} = 370 \ MHz, \ A \\ f_{IN} = 370 \ MHz, \ A \\ f_{IN} = 720 \ MHz, \ A \\ f_{IN} = 720 \ MHz, \ A \\ f_{IN} = 720 \ MHz, \ A \\ f_{IN} = 100 \ MHz, \ A \\ f_{IN} = 100 \ MHz, \ A \\ f_{IN} = 100 \ MHz, \ A \\ f_{IN} = 230 \ MHz, \ A \\ f_{IN} = 370 \ MHz, \ A \\ f_{IN} = 70 \ MHz, \ A \\ f_{IN} = 720 \ MHz, \ A \\ f_{IN} = -7 \ dBFS \\ f_{IN} = 465 \ MHz \\ A_{IN} = -7 \ dBFS \\ f_{IN} = 465 \ MHz \\ A_{IN} = -7 \ dBFS \\ f_{IN} = 465 \ MHz \\ A_{IN} = -7 \ dBFS \\ f_{IN} = -$	$\label{eq:result} Interleaving spur \end{tabular} \begin{tabular}{lllllllllllllllllllllllllllllllllll$	$\label{eq:results} Interleaving spure $$ f_{IN} = 10  MHz, A_{IN} = -1  dBFS$$ f_{IN} = 100  MHz, A_{IN} = -1  dBFS$$ 72 $$ f_{IN} = 100  MHz, A_{IN} = -1  dBFS$$ 72 $$ f_{IN} = 230  MHz, A_{IN} = -1  dBFS$$ $$ 72 $$ f_{IN} = 230  MHz, A_{IN} = -1  dBFS$$$ f_{IN} = 270  MHz, A_{IN} = -1  dBFS$$$ $$ f_{IN} = 370  MHz, A_{IN} = -1  dBFS$$$ $$ f_{IN} = 370  MHz, A_{IN} = -1  dBFS$$$ $$ f_{IN} = 470  MHz, A_{IN} = -3  dBFS$$$ $$ f_{IN} = 720  MHz$$$ $$ A_{IN} = -6  dBFS$$$ $$ $$ f_{IN} = 100  MHz, A_{IN} = -1  dBFS$$$ $$ $$ f_{IN} = 100  MHz, A_{IN} = -1  dBFS$$$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$$	$ \begin{tabular}{ c c c c c c } \label{eq:transform} $$ Interleaving spur $$ Interleaving s$	$\label{eq:results} Interleaving spure $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$$	

## 7.7 Digital Characteristics

typical values are at  $T_A = 25^{\circ}$ C, full temperature range is from  $T_{MIN} = -40^{\circ}$ C to  $T_{MAX} = +85^{\circ}$ C, ADC sampling rate = 1.0 GSPS, 50% clock duty cycle, AVDD3V = 3.0 V, AVDD = DVDD = 1.9 V, IOVDD = 1.15 V, -1-dBFS differential input, and 0-dB digital gain (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
DIGITAL I	NPUTS (RESET, SCLK, SEN, SDIN, SYN	C, PDN) <sup>(1)</sup>			I	
VIH	High-level input voltage	All digital inputs support 1.2-V and 1.8-V logic levels	0.8			V
VIL	Low-level input voltage	All digital inputs support 1.2-V and 1.8-V logic levels			0.4	V
		SEN		0		μA
IIH	High-level input current	RESET, SCLK, SDIN, PDN, SYNC		50		
		SEN		50		
IIL	Low-level input current	RESET, SCLK, SDIN, PDN, SYNC		0		μA
DIGITAL I	NPUTS (SYSREFP, SYSREFM)					
V <sub>D</sub>	Differential input voltage		0.35	0.45	1.4	V
V <sub>(CM_DIG)</sub>	Common-mode voltage for SYSREF <sup>(2)</sup>			1.3		V
DIGITAL C	OUTPUTS (SDOUT, PDN <sup>(2)</sup> )					
V <sub>OH</sub>	High-level output voltage		DVDD - 0.1	DVDD		V
V <sub>OL</sub>	Low-level output voltage				0.1	V
DIGITAL C	OUTPUTS (JESD204B Interface: DxP, Dx	M) <sup>(3)</sup>				
V <sub>OD</sub>	Output differential voltage	With default swing setting		700		$mV_{PP}$
V <sub>OC</sub>	Output common-mode voltage			450		mV
	Transmitter short-circuit current	Transmitter pins shorted to any voltage between -0.25 V and 1.45 V	-100		100	mA
Z <sub>os</sub>	Single-ended output impedance			50		Ω
	Output capacitance	Output capacitance inside the device, from either output to ground		2		pF

The RESET, SCLK, SDIN, and PDN pins have a 20-kΩ (typical) internal pulldown resistor to ground, and the SEN pin has a 20-kΩ (typical) pullup resistor to IOVDD.

(2) When functioning as an OVR pin for channel B.

(3) 100- $\Omega$  differential termination.

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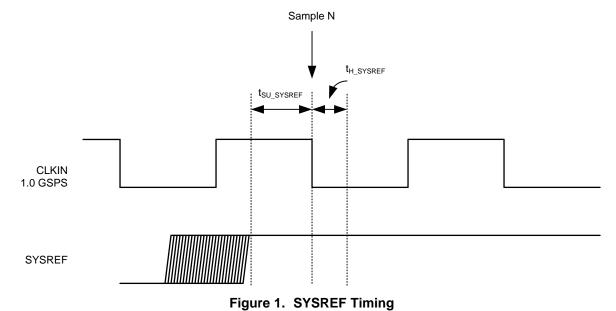
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## 7.8 Timing Characteristics

typical values are at  $T_A = 25^{\circ}$ C, full temperature range is from  $T_{MIN} = -40^{\circ}$ C to  $T_{MAX} = +85^{\circ}$ C, ADC sampling rate = 1.0 GSPS, 50% clock duty cycle, AVDD3V = 3.0 V, AVDD = DVDD = 1.9 V, IOVDD = 1.15 V, and -1-dBFS differential input (unless otherwise noted)

		MIN	TYP	MAX	UNITS
SAMPLE T	MING				
	Aperture delay	0.75		1.6	ns
	Aperture delay matching between two channels on the same device		±70		ps
	Aperture delay matching between two devices at the same temperature and supply voltage		±270		ps
	Aperture jitter		120		f <sub>S</sub> rms
WAKE-UP	ΓIMING				
	Wake-up time to valid data after coming out of global power-down		150		μs
LATENCY					
	Data latency <sup>(1)</sup> : ADC sample to digital output		134		Input clock cycles
	OVR latency: ADC sample to OVR bit		62		Input clock cycles
	FOVR latency: ADC sample to FOVR signal on pin		18 + 4 ns		Input clock cycles
t <sub>PD</sub>	Propagation delay: logic gates and output buffers delay (does not change with $\ensuremath{f_S}\xspace)$		4		ns
SYSREF TI	MING				
t <sub>SU_SYSREF</sub>	Setup time for SYSREF, referenced to the input clock falling edge	300		900	ps
t <sub>H_SYSREF</sub>	Hold time for SYSREF, referenced to the input clock falling edge	100			ps
JESD OUT	PUT INTERFACE TIMING CHARACTERISTICS				
	Unit interval	100		400	ps
	Serial output data rate	2.5		6.25	Gbps
	Total jitter for BER of 1E-15 and lane rate = 6.25 Gbps		26		ps
	Random jitter for BER of 1E-15 and lane rate = 6.25 Gbps		0.75		ps rms
	Deterministic jitter for BER of 1E-15 and lane rate = 6.25 Gbps		12		ps, pk-pk
t <sub>R</sub> , t <sub>F</sub>	Data rise time, data fall time: rise and fall times are measured from 20% to 80%, differential output waveform, 2.5 Gbps $\leq$ bit rate $\leq$ 6.25 Gbps		35		ps

(1) Overall ADC latency = data latency + t<sub>PDI</sub>.





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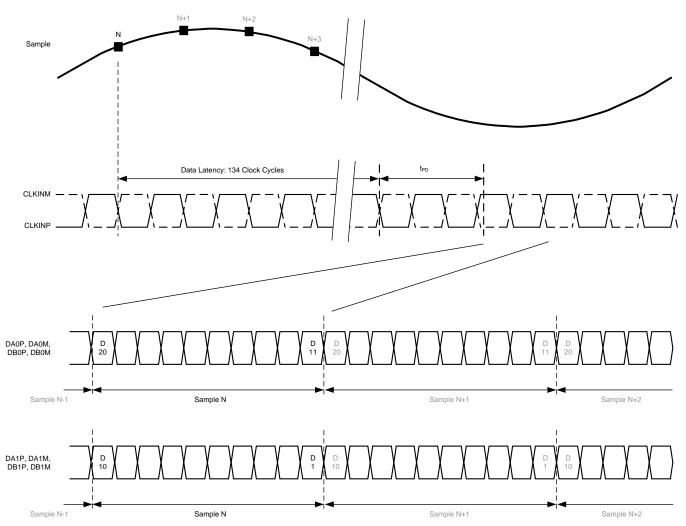


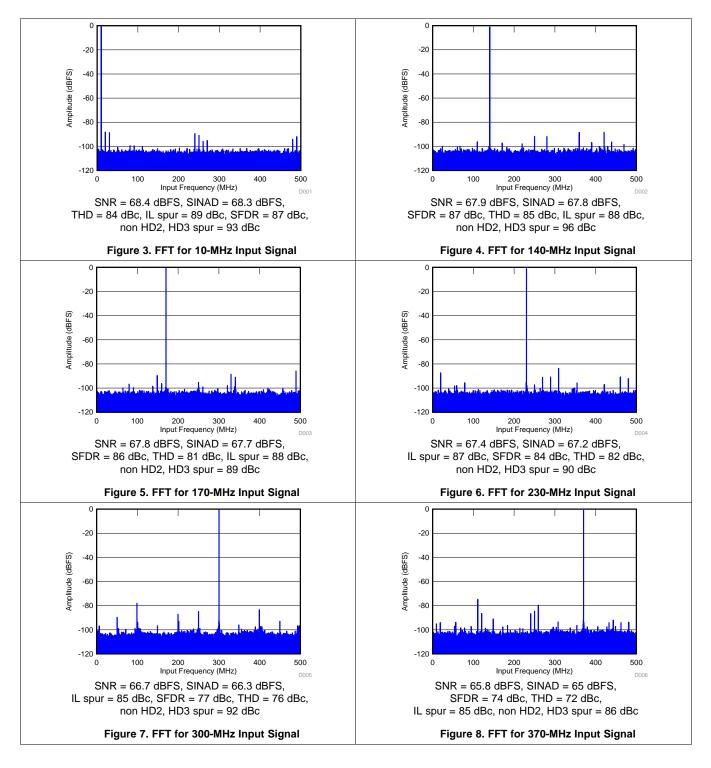
Figure 2. Sample Timing Requirements

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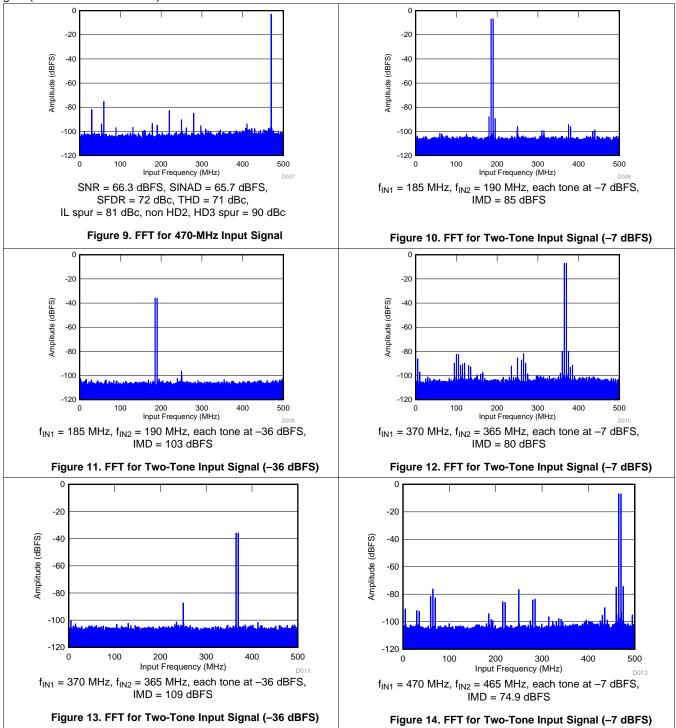
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## 7.9 Typical Characteristics





## **Typical Characteristics (continued)**



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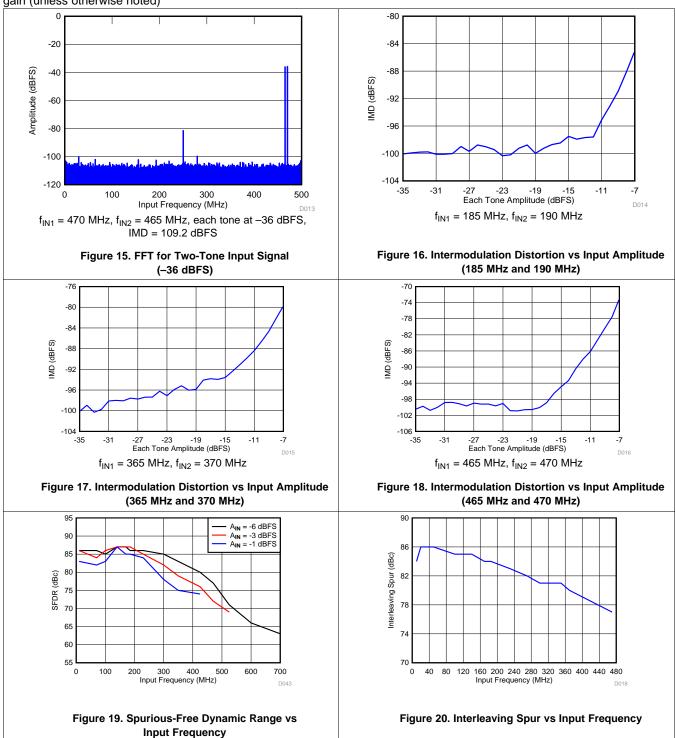
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**STRUMENTS** 

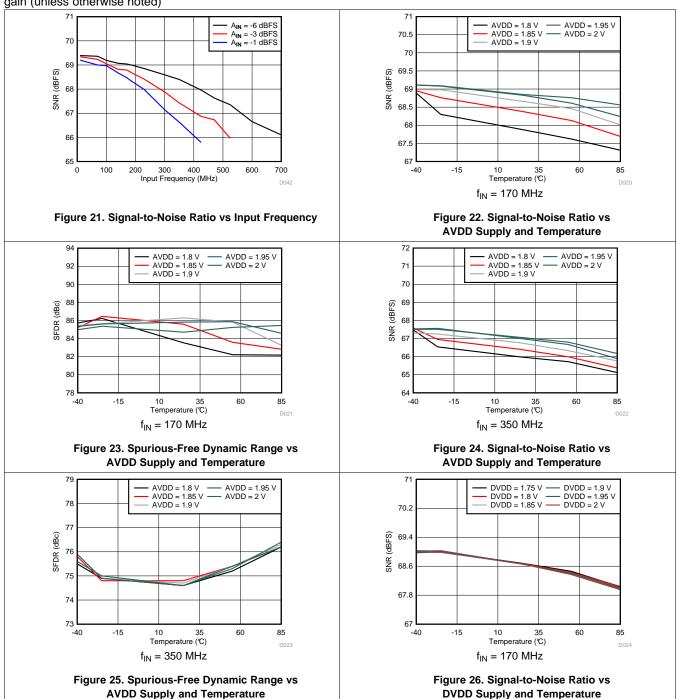
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## **Typical Characteristics (continued)**





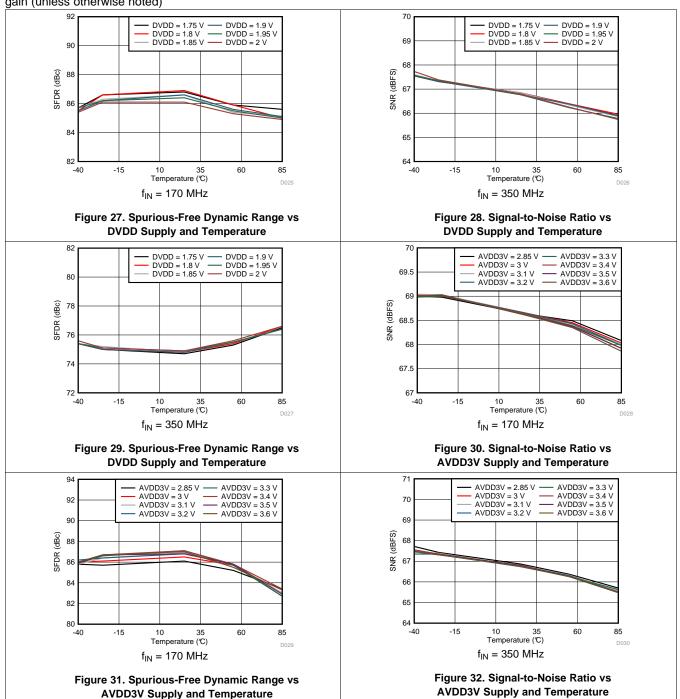
## **Typical Characteristics (continued)**



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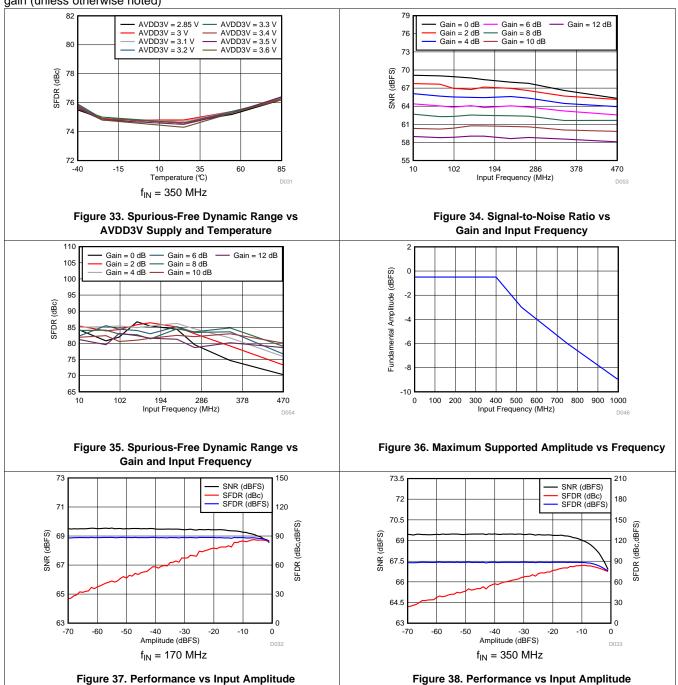
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## **Typical Characteristics (continued)**





## **Typical Characteristics (continued)**

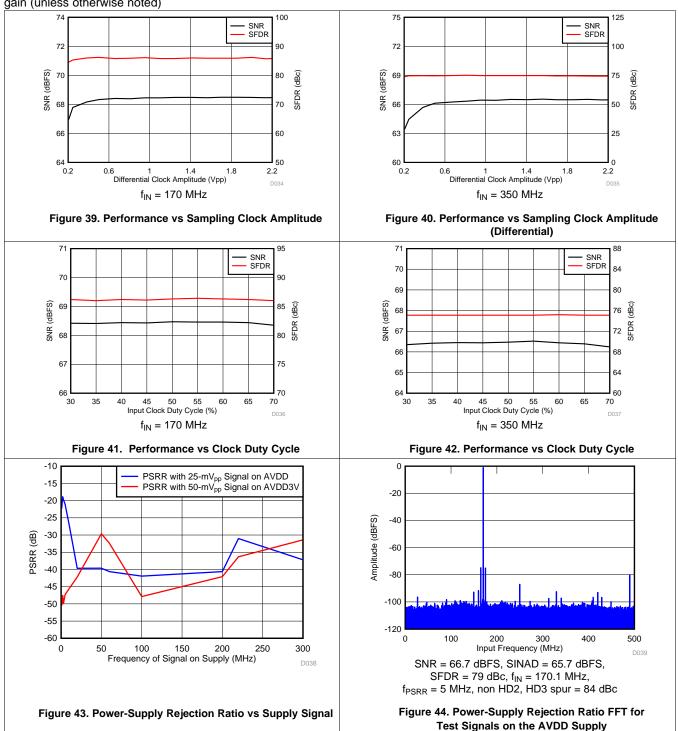


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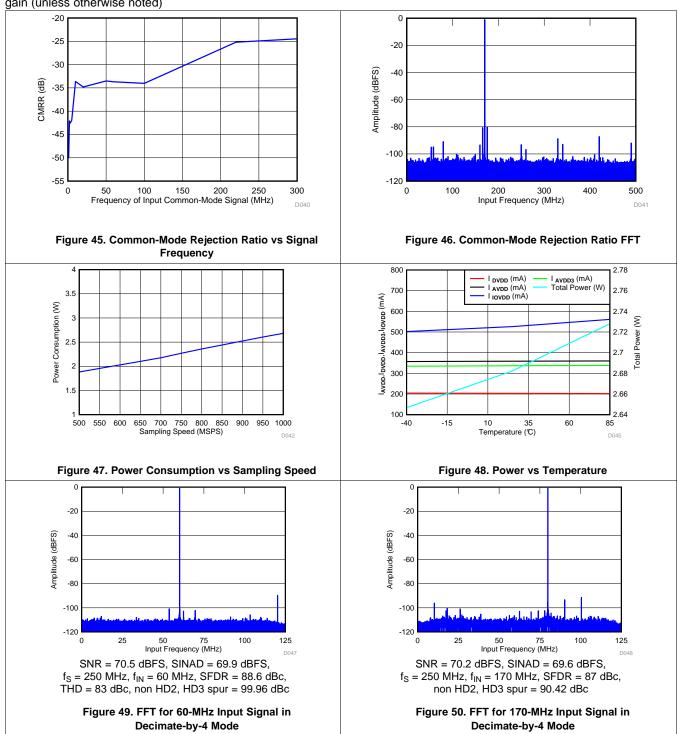
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## **Typical Characteristics (continued)**





## **Typical Characteristics (continued)**

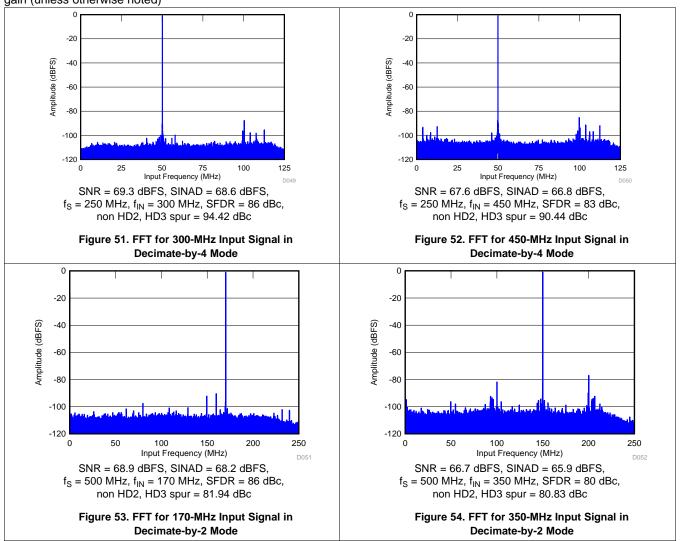


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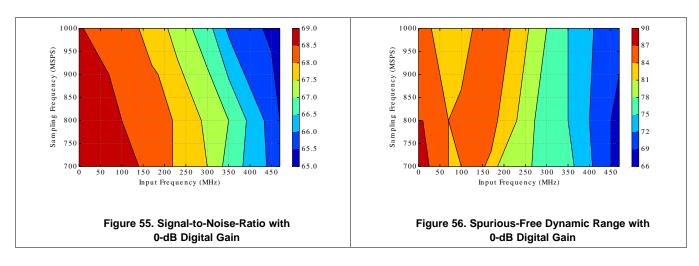
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## **Typical Characteristics (continued)**





## 7.10 Typical Characteristics: Contour



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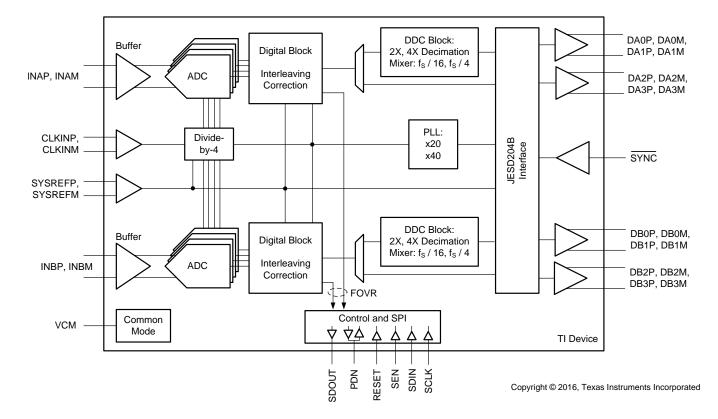
## 8 Detailed Description

## 8.1 Overview

The ADS54J20 is a low-power, wide-bandwidth, 12-bit, 1.0-GSPS, dual-channel, analog-to-digital converter (ADC). The ADS54J20 employs four interleaving ADCs for each channel to achieve a noise floor of –157 dBFS/Hz. The ADS54J20 uses TI's proprietary interleaving and dither algorithms to achieve a clean spectrum with a high spurious-free dynamic range (SFDR). The device also offers various programmable decimation filtering options for systems requiring higher signal-to-noise ratio (SNR) and SFDR over a wide range of frequencies.

Analog input buffers isolate the ADC driver from glitch energy generated from sampling process, thereby simplifying the driving network on-board. The JESD204B interface reduces the number of interface lines with two-lane and four-lane options, allowing for a high system integration density. The JESD204B interface operates in subclass 1, enabling multi-chip synchronization with the SYSREF input.

## 8.2 Functional Block Diagram





#### 8.3 Feature Description

#### 8.3.1 Analog Inputs

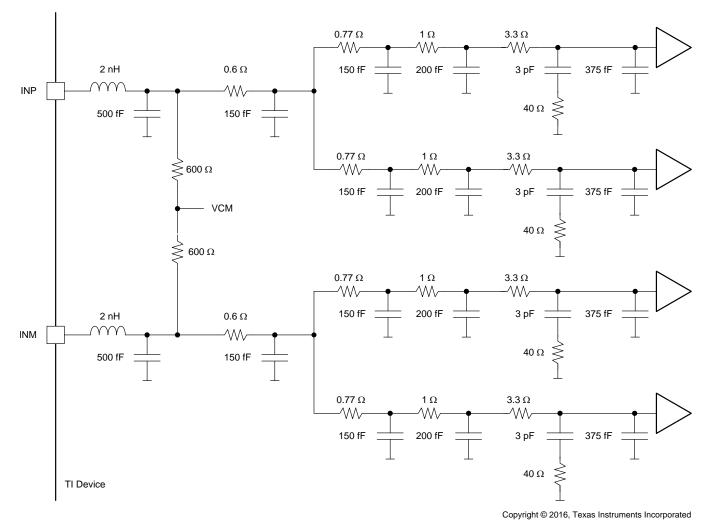
unal inpute are designed to be driven differentially. The englog input nine have internal

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The ADS54J20 analog signal inputs are designed to be driven differentially. The analog input pins have internal analog buffers that drive the sampling circuit. Resulting from the analog buffer, the input pins present a high impedance input across a very wide frequency range to the external driving source that enables great flexibility in the external analog filter design as well as excellent 50- $\Omega$  matching for RF applications. The buffer also helps isolate the external driving circuit from the internal switching currents of the sampling circuit, resulting in a more constant SFDR performance across input frequencies.

The common-mode voltage of the signal inputs is internally biased to VCM using  $600-\Omega$  resistors, allowing for accoupling of the input drive network. Each input pin (INP, INM) must swing symmetrically between (VCM + 0.475 V) and (VCM - 0.475 V), resulting in a 1.9-V<sub>PP</sub> (default) differential input swing. The input sampling circuit has a 3-dB bandwidth that extends up to 1.2 GHz. An equivalent analog input network diagram is shown in Figure 57.





## Feature Description (continued)

The input bandwidth shown in Figure 58 is measured with respect to a 50- $\Omega$  differential input termination at the ADC input pins.

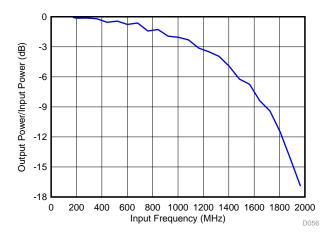
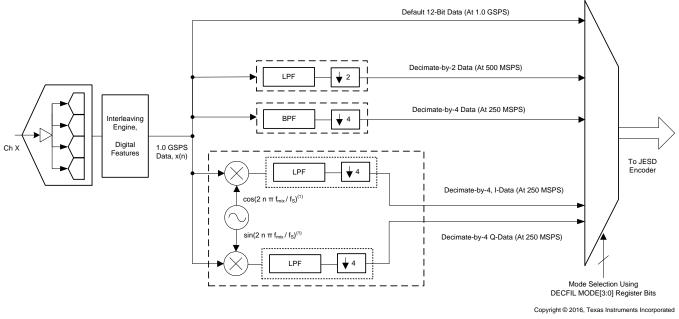


Figure 58. Transfer Function versus Frequency

## 8.3.2 DDC Block

The ADS54J20 has an optional digital down-converter (DDC) block that can be enabled via an SPI register write. Each ADC channel is followed by a DDC block consisting of three different decimate-by-2 and decimate-by-4 finite impulse response (FIR) half-band filter options. The different decimation filter options can be selected via SPI programming.

Figure 59 shows the signal processing done inside the DDC block of the ADS54J20.



(1) In IQ decimate-by-4 mode, the mixer frequency is fixed at  $f_{mix} = f_S / 4$ . For  $f_S = 1.0$  GSPS and  $f_{mix} = 250$  MHz.

Figure 59. DDC Block



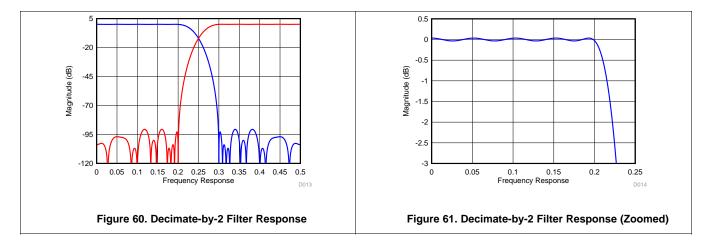
## Feature Description (continued)

#### 8.3.2.1 Decimate-by-2 Filter

This decimation filter has 41 taps. The stop-band attenuation is approximately 90 dB and the pass-band flatness is  $\pm 0.05$  dB. Table 1 shows corner frequencies for the low-pass and high-pass filter options.

CORNERS (dB)	LOW PASS	HIGH PASS
-0.1	0.202 × f <sub>S</sub>	0.298 × f <sub>S</sub>
-0.5	0.210 × f <sub>S</sub>	0.290 × f <sub>S</sub>
-1	0.215 × f <sub>S</sub>	0.285 × f <sub>S</sub>
-3	0.227 × f <sub>S</sub>	0.273 × f <sub>S</sub>

Figure 60 and Figure 61 show the frequency response of the decimate-by-2 filter from dc to  $f_S$  / 2.



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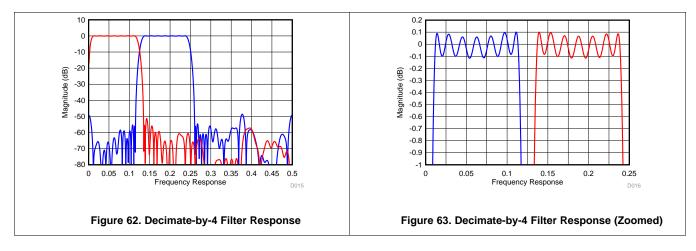
## 8.3.2.2 Decimate-by-4 Filter Using a Digital Mixer

This band-pass decimation filter consists of a digital mixer and three concatenated FIR filters with a combined latency of approximately 28 output clock cycles. The alias-band attenuation is approximately 55 dB and the pass-band flatness is  $\pm 0.1$  dB. By default after reset, the band-pass filter is centered at  $f_S$  / 16. Using the SPI, the center frequency can be programmed at N ×  $f_S$  / 16 (where N = 1, 3, 5, or 7). Table 2 shows corner frequencies for two extreme options.

CORNERS (dB)	CORNER FREQUENCY AT LOWER SIDE (Center Frequency f <sub>S</sub> / 16)	CORNER FREQUENCY AT HIGHER SIDE (Center Frequency f <sub>S</sub> / 16)
-0.1	0.011 × f <sub>S</sub>	0.114 × f <sub>S</sub>
-0.5	0.010 × f <sub>S</sub>	0.116 × f <sub>S</sub>
-1	0.008 × f <sub>S</sub>	0.117 × f <sub>S</sub>
-3	0.006 × f <sub>S</sub>	0.120 × f <sub>S</sub>

#### Table 2. Corner frequencies for the Decimate-by-4 Filter

Figure 62 and Figure 63 show the frequency response of the decimate-by-4 filter for center frequencies  $f_S / 16$  and  $3 \times f_S / 16$  (N = 1 and N = 3, respectively).



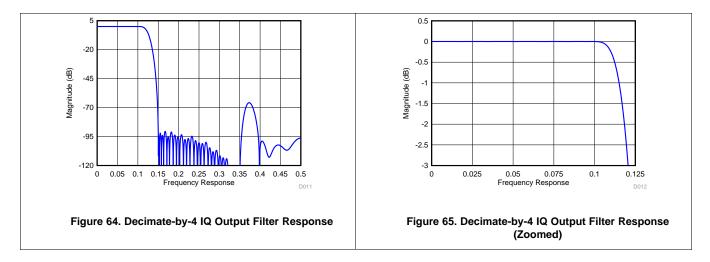
## 8.3.2.3 Decimate-by-4 Filter with IQ Outputs

In this configuration, the DDC block includes a fixed digital  $f_S / 4$  mixer. Thus, the IQ pass band is approximately ±0.11  $f_S$ , centered at  $f_S / 4$ . This decimation filter has 41 taps with a latency of approximately ten output clock cycles. The stop-band attenuation is approximately 90 dB and the pass-band flatness is ±0.05 dB. Table 3 shows the corner frequencies for a low-pass, decimate-by-4 IQ filter.

CORNERS (dB)	LOW PASS
-0.1	0.107 × f <sub>S</sub>
-0.5	0.112 × f <sub>S</sub>
-1	0.115 × f <sub>S</sub>
-3	0.120 × f <sub>S</sub>



## Figure 64 and Figure 65 show the frequency response of a decimate-by-4 IQ output filter from dc to $f_S$ / 2.



## 8.3.3 SYSREF Signal

The SYSREF signal is a periodic signal that is sampled by the ADS54J20 device clock and used to align the boundary of the local multiframe clock inside the data converter. SYSREF is required to be a sub-harmonic of the local multiframe clock (LMFC) internal timing. To meet this requirement, the timing of SYSREF is dependent on the device clock frequency and the LMFC frequency, as determined by the selected DDC decimation and frames per multiframe settings. The SYSREF signal is recommended to be a low-frequency signal in the range of 1 MHz to 5 MHz to reduce coupling to the signal path both on the printed circuit board (PCB) as well as internal to the device.

The external SYSREF signal must be a sub-harmonic of the internal LMFC clock, as shown in Equation 1 and Table 4.

SYSREF = LMFC /  $2^{N}$ 

where

• N = 0, 1, 2, and so forth

#### Table 4. LMFSC Clock Frequency

LMFS CONFIGURATION	DECIMATION	LMFC CLOCK <sup>(1)(2)</sup>
4211	_	f <sub>S</sub> / K
4244	_	(f <sub>S</sub> / 4) / K
8224	_	(f <sub>S</sub> / 4) / K
4222	2X	(f <sub>S</sub> / 4) / K
2242	2X	(f <sub>S</sub> / 4) / K
2221	4X	(f <sub>S</sub> / 4) / K
2441	4X (IQ)	(f <sub>S</sub> / 4) / K
4421	4X (IQ)	(f <sub>S</sub> / 4) / K
1241	4X	(f <sub>S</sub> / 4) / K

(1) K = Number of frames per multiframe (JESD digital page 6900h, address 06h, bits 4-0).

(2)  $f_S = \text{sampling (device) clock frequency.}$ 

(1)

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For example, if LMFS = 8224, the default value of K is 8 + 1 = 9 (the actual value for K = the value set in the SPI register + 1). If the device clock frequency is  $f_S = 1.0$  GSPS, then the local multiframe clock frequency becomes (1000 / 4) / 9 = 27.778 MHz. The SYSREF signal frequency can be chosen as LMFC frequency / 8 = 3.47222 MHz.

## 8.3.3.1 SYSREF Not Present (Subclass 0, 2)

A SYSREF pulse is required by the ADS54J20 to reset internal counters. If SYSREF is not present, as can be the case in subclass 0 or 2, this pulse can be done by doing the following register writes shown in Table 5.

# Table 5. Internally Pulsing SYSREF Twice Using Register Writes

ADDRESS (Hex)	DATA (Hex)	COMMENT
0-011h	80h	Set the master page
0-054h	80h	Enable manual SYSREF
0-053h	01h	Set SYSREF high
0-053h	00h	Set SYSREF low
0-053h	01h	Set SYSREF high
0-053h	00h	Set SYSREF low



#### 8.3.4 Overrange Indication

The ADS54J20 provides a fast overrange indication that can be presented in the digital output data stream via SPI configuration. Alternatively, if not used, the SDOUT (pin 11) and PDN (pin 50) pins can be configured via the SPI to output the fast OVR indicator.

The JESD 8b, 10b encoder receives 16-bit data that are formed by 12-bit ADC data padded with four 0s as LSBs. When the FOVR indication is embedded in the output data stream, the LSB of the 16-bit data stream going to the 8b, 10b encoder is replaced, as shown in Figure 66.

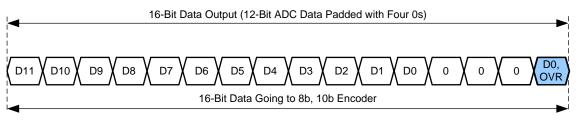


Figure 66. Overrange Indication in a Data Stream

## 8.3.4.1 Fast OVR

The fast OVR is triggered if the input voltage exceeds the programmable overrange threshold and is presented after only 18 clock cycles +  $t_{PD}$  ( $t_{PD}$  of the gates and buffers is approximately 4 ns), thus enabling a quicker reaction to an overrange event.

The input voltage level that the overload is detected at is referred to as the *threshold*. The threshold is programmable using the FOVR THRESHOLD bits, as shown in Figure 67. The FOVR is triggered 18 clock cycles  $+ t_{PD}$  ( $t_{PD}$  of the gates and buffers is approximately 4 ns) after the overload condition occurs.

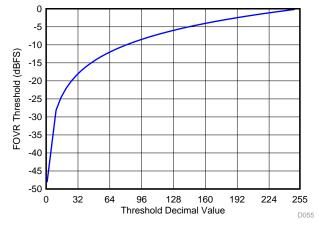


Figure 67. Programming Fast OVR Thresholds

The input voltage level that the fast OVR is triggered at is defined by Equation 2: Full-Scale × [Decimal Value of the FOVR Threshold Bits] / 255)	(2)
The default threshold is E3h (227d), corresponding to a threshold of $-1$ dBFS.	
In terms of full-scale input, the fast OVR threshold can be calculated as Equation 3: 20log (FOVR Threshold / 255)	(3)



#### 8.3.5 Power-Down Mode

The ADS54J20 provides a highly-configurable power-down mode. Power-down can be enabled using the PDN pin or SPI register writes.

A power-down mask can be configured that allows a trade-off between wake-up time and power consumption in power-down mode. Two independent power-down masks can be configured: MASK 1 and MASK 2, as shown in Table 6. See the master page registers in Table 15 for further details.

REGISTER ADDRESS	DDRESS COMMENT	REGISTER DATA							
A[7:0] (Hex)		7	6	5	4	3	2	1	0
MASTER PAG	E (80h)								
20		PDN ADC CHA					PDN A	DC CHB	
21	MASK 1 PDN BU		FER CHB	PDN BUFFER CHA		0	0	0	0
23	MASK 2		PDN ADC CHA				PDN A	DC CHB	
24	MASK 2	PDN BUFFER CHB		PDN BUF	FER CHA	0	0	0	0
26	CONFIG	GLOBAL PDN	OVERRIDE PDN PIN	PDN MASK SEL	0	0	0	0	0
53		0	MASK SYSREF	0	0	0	0	0	0
55		0	0	0	PDN MASK	0	0	0	0

## Table 6. Register Addresses for Power-Down Modes

To save power, the device can be put in complete power-down by using the GLOBAL PDN register bit. However, when JESD is required to remain active when putting the device in power-down, the ADC and analog buffer can be powered down by using the PDN ADC CHx and PDN BUFFER CHx register bits after enabling the PDN MASK register bit. The PDN MASK SEL register bit can be used to select between MASK 1 or MASK 2. Table 7 shows the power consumption for different combinations of the GLOBAL PDN, PDN ADC CHx, and PDN BUFF CHx register bits.

REGISTER BIT	COMMENT	I <sub>AVDD3V</sub> (mA)	I <sub>AVDD</sub> (mA)	l <sub>DVDD</sub> (mA)	l <sub>IOVDD</sub> (mA)	TOTAL POWER (W)
Default	After reset, with a full-scale input signal to both channels	247	260	137	382	1.94
GBL PDN = 1	The device is in a complete power-down state	3	6	23	192	0.28
$ \begin{array}{l} GBL\;PDN=0,\\ PDN\;ADC\;CHx=1\\ (x=A\;or\;B) \end{array} $	The ADC of one channel is powered down	206	166	97	367	1.54
GBL PDN = 0, PDN BUFF CHx = 1 (x = A or B)	The input buffer of one channel is powered down	195	258	137	381	1.78
	The ADC and input buffer of one channel are powered down	152	166	97	363	1.37
	The ADC and input buffer of both channels are powered down	55	70	56	356	0.81



#### 8.4 Device Functional Modes

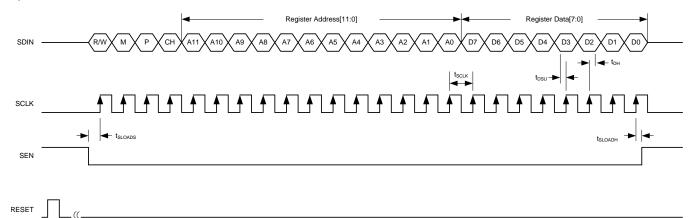
#### 8.4.1 Device Configuration

The ADS54J20 can be configured by using a serial programming interface, as described in the *Serial Interface* section. In addition, the device has one dedicated parallel pin (PDN) for controlling the power-down mode.

The ADS54J20 supports a 24-bit (16-bit address, 8-bit data) SPI operation and uses paging (see the *Register Maps* section) to access all register bits.

#### 8.4.1.1 Serial Interface

The ADC has a set of internal registers that can be accessed by the serial interface formed by the SEN (serial interface enable), SCLK (serial interface clock), and SDIN (serial interface data) pins, as shown in Figure 68. SPI bits in Figure 68 are explained in Table 8. Serially shifting bits into the device is enabled when SEN is low. Serial data on SDIN are latched at every SCLK rising edge when SEN is active (low). The interface can function with SCLK frequencies from 2 MHz down to very low speeds (of a few Hertz) and also with a non-50% SCLK duty cycle.



## Figure 68. SPI Timing Diagram

#### Table 8. SPI Timing Diagram Legend

SPI BITS	DESCRIPTION	BIT SETTINGS
R/W	Read/write bit	0 = SPI write 1 = SPI read back
М	SPI bank access	0 = Analog SPI bank (master and ADC pages) 1 = JESD SPI bank (main digital, JESD analog, and JESD digital pages)
Р	JESD page selection bit	0 = Page access 1 = Register access
СН	SPI access for a specific channel of the JESD SPI bank	0 = Channel A 1 = Channel B By default, both channels are being addressed.
A[11:0]	SPI address bits	—
D[7:0]	SPI data bits	_

Table 9 shows the timing requirements for the serial interface signals in Figure 68.

Table 9.	SPI	Timing	Requirements
----------	-----	--------	--------------

		MIN	ТҮР	MAX	UNIT
f <sub>SCLK</sub>	SCLK frequency (equal to 1 / t <sub>SCLK</sub> )	> dc		2	MHz
t <sub>SLOADS</sub>	SEN to SCLK setup time	100			ns
t <sub>SLOADH</sub>	SCLK to SEN hold time	100			ns
t <sub>DSU</sub>	SDIN setup time	100			ns
t <sub>DH</sub>	SDIN hold time	100			ns

## 8.4.1.2 Serial Register Write: Analog Bank

The analog SPI bank contains two pages (the master and ADC pages). The internal register of the ADS54J20 analog SPI bank can be programmed by:

- 1. Driving the SEN pin low.
- 2. Initiating a serial interface cycle specifying the page address of the register whose content must be written.
  - Master page: write address 0011h with 80h.
  - ADC page: write address 0011h with 0Fh.
- 3. Writing the register content as shown in Figure 69. When a page is selected, multiple writes into the same page can be done.

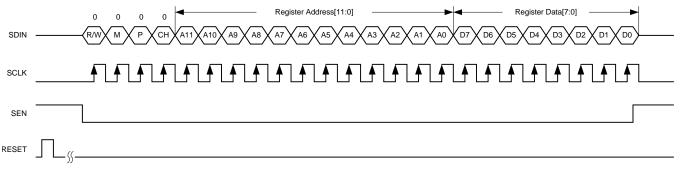


Figure 69. Serial Register Write Timing Diagram



#### 8.4.1.3 Serial Register Readout: Analog Bank

The content from one of the two analog banks can be read out by:

- 1. Driving the SEN pin low.
- 2. Selecting the page address of the register whose content must be read.
  - Master page: write address 0011h with 80h.
  - ADC page: write address 0011h with 0Fh.
- 3. Setting the R/W bit to 1 and writing the address to be read back.
- 4. Reading back the register content on the SDOUT pin, as shown in Figure 70. When a page is selected, multiple read backs from the same page can be done.

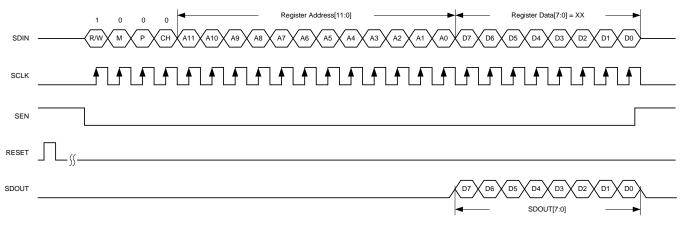
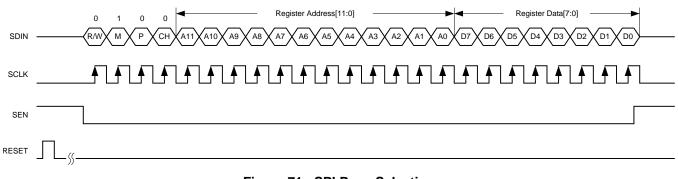


Figure 70. Serial Register Read Timing Diagram

#### 8.4.1.4 JESD Bank SPI Page Selection

The JESD SPI bank contains three pages (main digital, JESD digital, and JESD analog pages). The individual pages can be selected by:

- 1. Driving the SEN pin low.
- 2. Setting the M bit to 1 and specifying the page with two register writes. Note that the P bit must be set to 0, as shown in Figure 71.
  - Write address 4003h with 00h (LSB byte of the page address).
  - Write address 4004h with the MSB byte of the page address.
    - For the main digital page: write address 4004h with 68h.
    - For the JESD digital page: write address 4004h with 69h.
    - For the JESD analog page: write address 4004h with 6Ah.



## Figure 71. SPI Page Selection

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## 8.4.1.5 Serial Register Write: JESD Bank

The ADS54J20 is a dual-channel device and the JESD204B portion is configured individually for each channel by using the CH bit. Note that the P bit must be set to 1 for register writes.

- 1. Drive the SEN pin low.
- 2. Select the JESD bank page. Note that the M bit = 1 and the P bit = 0.
  - Write address 4003h with 00h.
  - Write address 4005h with 01h to enable separate control for both channels.
    - For the main digital page: write address 4004h with 68h.
    - For the JESD digital page: write address 4004h with 69h.
    - For the JESD analog page: write address 4004h with 6Ah.
- 3. Set the M and P bits to 1, select channel A (CH = 0) or channel B (CH = 1), and write the register content as shown in Figure 72. When a page is selected, multiple writes into the same page can be done.

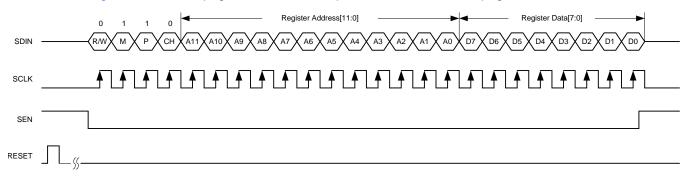


Figure 72. JESD Serial Register Write Timing Diagram

#### 8.4.1.5.1 Individual Channel Programming

By default, register writes are applied to both channels. To enable individual channel writes, write address 4005h with 01h (default is 00h).

#### 8.4.1.6 Serial Register Readout: JESD Bank

The content from one of the pages of the JESD bank can be read out by:

- 1. Driving the SEN pin low.
- 2. Selecting the JESD bank page. Note that the M bit = 1 and the P bit = 0.
  - Write address 4003h with 00h.
  - Write address 4005h with 01h to enable separate control for both channels.
    - For the main digital page: write address 4004h with 68h.
    - For the JESD digital page: write address 4004h with 69h.
    - For the JESD analog page: write address 4004h with 6Ah.
- 3. Setting the R/W, M, and P bits to 1, selecting channel A or channel B, and writing the address to be read back.
- 4. Reading back the register content on the SDOUT pin; see Figure 73. When a page is selected, multiple read backs from the same page can be done.



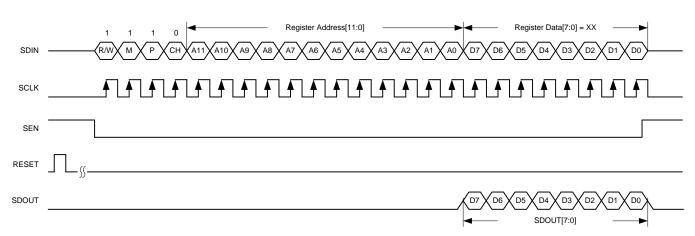


Figure 73. JESD Serial Register Read Timing Diagram

# 8.4.2 JESD204B Interface

The ADS54J20 supports device subclass 1 with a maximum output data rate of 6.25 Gbps for each serial transmitter.

An external SYSREF signal is used to align all internal clock phases and the local multiframe clock to a specific sampling clock edge, allo<u>wing</u> synchronization of multiple devices in a system and minimizing timing and alignment uncertainty. The SYNC input is used to control the JESD204B SerDes blocks.

Depending on the ADC output data rate, the JESD204B output interface can be operated with either two or four lanes per single ADC, as shown in Figure 74. The JESD204B setup and configuration of the frame assembly parameters is controlled via the SPI interface.

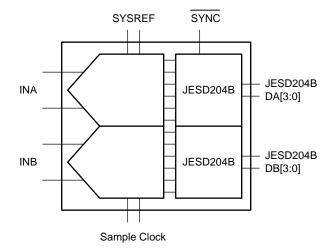


Figure 74. ADS54J20 Block Diagram

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The JESD204B transmitter block shown in Figure 75 consists of the transport layer, the data scrambler, and the link layer. The transport layer maps the ADC output data into the selected JESD204B frame data format. The link layer performs the 8b, 10b data encoding as well as the synchronization and initial lane alignment using the SYNC input signal. Optionally, data from the transport layer can be scrambled.

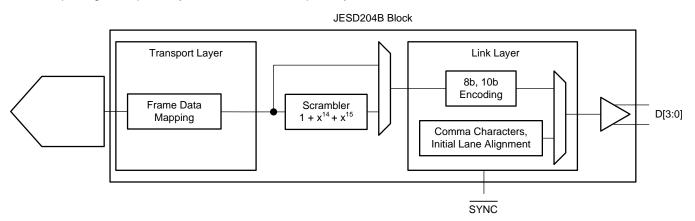


Figure 75. JESD204B Transmitter Block

# 8.4.2.1 JESD204B Initial Lane Alignment (ILA)

The initial lane alignment process is started when the receiving device deasserts the SYNC signal, as shown in Figure 76. When a logic low is detected on the SYNC input pin, the ADS54J20 starts transmitting comma (K28.5) characters to establish a code group synchronization.

When synchronization is complete, the receiving device asserts the SYNC signal and the ADS54J20 starts the initial lane alignment sequence with the next local multiframe clock boundary. The ADS54J20 transmits four multiframes, each containing K frames (K is SPI programmable). Each of the multiframes contains the frame start and end symbols and the second multiframe also contains the JESD204 link configuration data.

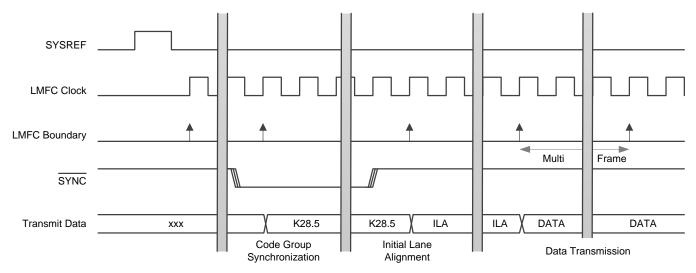


Figure 76. Lane Alignment Sequence



#### 8.4.2.2 JESD204B Test Patterns

There are three different test patterns available in the transport layer of the JESD204B interface. The ADS54J20 supports a clock output, encoded, and a PRBS  $(2^{15} - 1)$  pattern. These test patterns can be enabled via an SPI register write and are located in the JESD digital page of the JESD bank.

# 8.4.2.3 JESD204B Frame

The JESD204B standard defines the following parameters:

- L is the number of lanes per link.
- M is the number of converters per device.
- F is the number of octets per frame clock period, per lane.
- S is the number of samples per frame per converter.

# 8.4.2.4 JESD204B Frame

Table 10 lists the available JESD204B formats and valid ranges for the ADS54J20 when the decimation filter is not used. The ranges are limited by the SerDes lane rate and the maximum ADC sample frequency.

#### NOTE

The 16-bit data going to the JESD 8b, 10b encoder are formed by padding four 0s as LSBs into the 12-bit ADC data.

				MINIMU	M RATES	MAXIMUM RATES							
L	М	F	S	DECIMATION	SAMPLING RATE (MSPS)	SERDES BIT RATE (Gbps)	SAMPLING RATE (MSPS)	SERDES BIT RATE (Gbps)					
4	2	1	1	Not used	250	2.5	1000	10.0					
4	2	4	4	Not used	250	2.5	1000	10.0					
8	2	2	4	Not used	500	2.5	1000	5.0					

# Table 10. Default Interface Rates

#### NOTE

In the LMFS = 8224 row of Table 11, the sample order on the lanes is DA2, DA3, DA1, and DA0 for channel A. Similarly for channel B, the sample order on the lanes is DB2, DB3, DB1, and DB0.

The detailed frame assembly is shown in Table 11.

Table 1	1. Default	Frame	Assembly <sup>(1)</sup>
---------	------------	-------	-------------------------

OUTPUT LANE	LMFS = 4211		LMFS	= 4244		LMFS	= 8224
DA0						A <sub>3</sub> [11:4]	A <sub>3</sub> [3:0], 0000
DA1	A <sub>0</sub> [3:0], 0000	A <sub>2</sub> [11:4]	A <sub>2</sub> [3:0], 0000	A <sub>3</sub> [11:4]	A <sub>3</sub> [3:0], 0000	A <sub>2</sub> [11:4]	A <sub>2</sub> [3:0], 0000
DA2	A <sub>0</sub> [11:4]	A <sub>0</sub> [11:4]	A <sub>0</sub> [3:0], 0000	A <sub>1</sub> [11:4]	A <sub>1</sub> [3:0], 0000	A <sub>0</sub> [11:4]	A <sub>0</sub> [3:0], 0000
DA3						A <sub>1</sub> [11:4]	A <sub>1</sub> [3:0], 0000
DB0						B <sub>3</sub> [11:4]	B <sub>3</sub> [3:0], 0000
DB1	B <sub>0</sub> [3:0], 0000	B <sub>2</sub> [11:4]	B <sub>2</sub> [3:0], 0000	B <sub>3</sub> [11:4]	B <sub>3</sub> [3:0], 0000	B <sub>2</sub> [11:4]	B <sub>2</sub> [3:0], 0000
DB2	B <sub>0</sub> [11:4]	B <sub>0</sub> [11:4]	B <sub>0</sub> [3:0], 0000	B <sub>1</sub> [11:4]	B <sub>1</sub> [3:0], 0000	B <sub>0</sub> [11:4]	B <sub>0</sub> [3:0], 0000
DB3						B <sub>1</sub> [11:4]	B <sub>1</sub> [3:0], 0000

(1) Blue shading indicates channel A and yellow shading indicates channel B.

# 8.4.2.5 JESD204B Frame Assembly with Decimation

Table 12 lists the available JESD204B formats and valid ranges for the ADS54J20 when enabling the decimation filter. The ranges are limited by the SerDes lane rate (2.5 Gbps to 10.0 Gbps) and the ADC sample frequency (300 MSPS to 1000 MSPS).

						MINIMUM RATES	;	MAXIMUM RATES			
L	м	F	S	DECIMATION	DEVICE CLOCK FREQUENCY (MSPS)	OUTPUT SAMPLE RATE (MSPS)	SERDES BIT RATE (Gbps)	DEVICE CLOCK FREQUENCY (MSPS)	OUTPUT SAMPLE RATE (MSPS)	SERDES BIT RATE (Gbps)	
4	4	2	1	4X (IQ)	500	125	2.5	1000	250	5	
4	2	2	2	2X	500	250	2.5	1000	500	5	
2	2	4	2	2X	300	150	3	1000	500	10	
2	2	2	1	4X	500	125	2.5	1000	250	5	
2	4	4	1	4X (IQ)	300	75	3	1000	250	10	
1	2	4	1	4X	300	75	3	1000	250	10	

# Table 12. Interface Rates with Decimation Filter

 Table 13 lists the detailed frame assembly with different decimation options.

 Table 13. Frame Assembly with Decimation Filter<sup>(1)</sup>

OUTPUT LANE		4222, 2X ATION	LMFS = 2242, 2X DECIMATION		LMFS = 2221, 4X DECIMATION		42	LMFS CDECIM	= 2441, ATION (I	ב)		4421, 4X TION (IQ)			= 1241, IMATION			
DA0	A <sub>1</sub> [11:4]	A <sub>1</sub> [3:0], 0000											AQ <sub>0</sub> [11:4]	AQ <sub>0</sub> [3:0], 0000				
DA1	A <sub>0</sub> [11:4]	A <sub>0</sub> [3:0], 0000	A <sub>0</sub> [11:4]	A <sub>0</sub> [3:0], 0000	A <sub>1</sub> [11:4]	A <sub>1</sub> [3:0], 0000	A <sub>0</sub> [11:4]	A <sub>0</sub> [3:0], 0000	Al <sub>0</sub> [11:4]	Al <sub>0</sub> [3:0], 0000	AQ <sub>0</sub> [11:4]	AQ <sub>0</sub> [3:0], 0000	Al <sub>0</sub> [11:4]	Al <sub>0</sub> [3:0], 0000	A <sub>0</sub> [11:4]	A <sub>0</sub> [3:0], 0000	B <sub>0</sub> [11:4]	B <sub>0</sub> [3:0], 0000
DA2																		
DA3																		
DB0	B <sub>1</sub> [11:4]	B <sub>1</sub> [3:0], 0000											BQ <sub>0</sub> [11:4]	BQ <sub>0</sub> [3:0], 0000				
DB1	B <sub>0</sub> [11:4]	B <sub>0</sub> [3:0], 0000	B <sub>0</sub> [11:4]	B <sub>0</sub> [3:0], 0000	B <sub>1</sub> [11:4]	B <sub>1</sub> [3:0], 0000	B <sub>0</sub> [11:4]	B <sub>0</sub> [3:0], 0000	Bl <sub>0</sub> [11:4]	Bl <sub>0</sub> [3:0], 0000	BQ <sub>0</sub> [11:4]	BQ <sub>0</sub> [3:0], 0000	Bl <sub>0</sub> [11:4]	Bl <sub>0</sub> [3:0], 0000				
DB2																		
DB3																		

(1) Blue shading indicates channel A and yellow shading indicates channel B.





Appropriate register bits must be programmed to enable different options when the decimation filter is enabled. Table 14 summarizes all the decimation filter options available in the DDC block, the corresponding JESD link parameters (L, M, F, and S), and the register bits required to be programmed for each option.

LM	FS O	PTIC	ONS		DDC MOD	ES PROGRAMMING				JESD LI	NK (LMFS) PROGR	AMMING		
L	м	F	s	DECIMATION OPTIONS	DEC MODE EN, DECFIL EN <sup>(3)</sup>	DECFIL MODE[3:0] <sup>(4)</sup>	JESD FILTER <sup>(5)</sup>	JESD MODE <sup>(6)</sup>	JESD PLL MODE <sup>(7)</sup>	LANE SHARE <sup>(8)</sup>	DA_BUS_ REORDER <sup>(9)</sup>	DB_BUS_ REORDER <sup>(10)</sup>	BUS_REORDER EN1 <sup>(11)</sup>	BUS_REORDER EN2 <sup>(12)</sup>
4	2	1	1	No decimation	00	00	000	100	10	0	00h	00h	0	0
4	2	4	4	No decimation	00	00	000	010	10	0	00h	00h	0	0
8	2	2	4	No decimation (Default after reset)	00	00	000	001	00	0	00h	00h	0	0
4	4	2	1	4X (IQ)	11	0011 (LPF with f <sub>S</sub> / 4 mixer)	111	001	00	0	0Ah	0Ah	1	1
4	2	2	2	2X	11	0010 (LPF) or 0110 (HPF)	110	001	00	0	0Ah	0Ah	1	1
2	2	4	2	2X	11	0010 (LPF) or 0110 (HPF)	110	010	10	0	0Ah	0Ah	1	1
2	2	2	1	4X	11	0000, 0100, 1000, or 1100 (all BPFs with different center frequencies).	100	001	00	0	0Ah	0Ah	1	1
2	4	4	1	4X (IQ)	11	0011 (LPF with an f <sub>S</sub> / 4 mixer)	111	010	10	0	0Ah	0Ah	1	1
1	2	4	1	4X	11	0000, 0100, 1000, or 1100 (all BPFs with different center frequencies)	100	010	10	1	0Ah	0Ah	1	1

# Table 14. Program Summary of DDC Modes and JESD Link Configuration<sup>(1)(2)</sup>

(1) Keeping the same LMFS settings for both channels is recommended.

(2) The PULSE RESET register bit must be pulsed after the registers in the main digital page are programmed.

(3) The DEC MODE EN and DECFIL EN register bits are located in the main digital page, register 04Dh (bit 3) and register 041h (bit 4).

(4) The DECFIL MODE[3:0] register bits are located in the main digital page, register 041h (bits 5 and 2-0).

(5) The JESD FILTER register bits are located in the JESD digital page, register 001h (bits 5-3).

(6) The JESD MODE register bits are located in the JESD digital page, register 001h (bits 2-0).

(7) The JESD PLL MODE register bits are located in the JESD analog page, register 016h (bits 1-0).

(8) The LANE SHARE register bit is located in the JESD digital page, register 016h (bit 4).

(9) The DA\_BUS\_REORDER register bits are located in the JESD digital page, register 031h (bits 7-0).

(10) The DB\_BUS\_REORDER register bits are located in the JESD digital page, register 032h (bits 7-0).

(11) The BUS\_REORDER EN1 register bit is located in the main digital page, register 052h (bit 7).

(12) The BUS\_REORDER EN2 register bit is located in the main digital page, register 072h (bit 3).



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# 8.4.2.5.1 JESD Transmitter Interface

Each of the 6.25-Gbps SerDes JESD transmitter outputs require ac-coupling between the transmitter and receiver. The differential pair must be terminated with  $100-\Omega$  resistors as close to the receiving device as possible to avoid unwanted reflections and signal degradation, as shown in Figure 77.

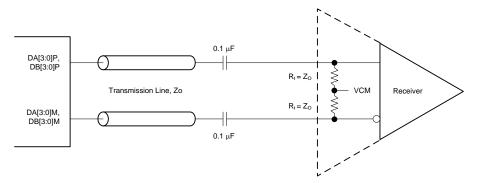
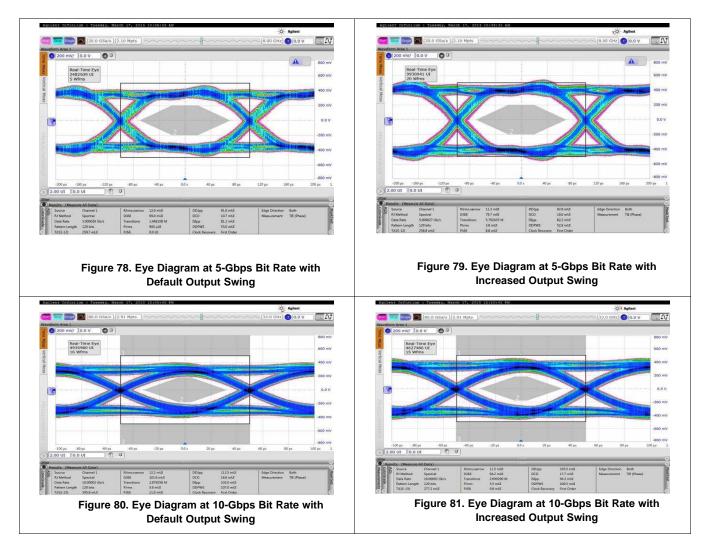


Figure 77. Output Connection to Receiver



# 8.4.2.5.2 Eye Diagrams

Figure 78 to Figure 81 show the serial output eye diagrams of the ADS54J20 at 5.0 Gbps and 10 Gbps with default and increased output voltage swing against the JESD204B mask.





# 8.5 Register Maps

Figure 82 shows a conceptual diagram of the serial registers.

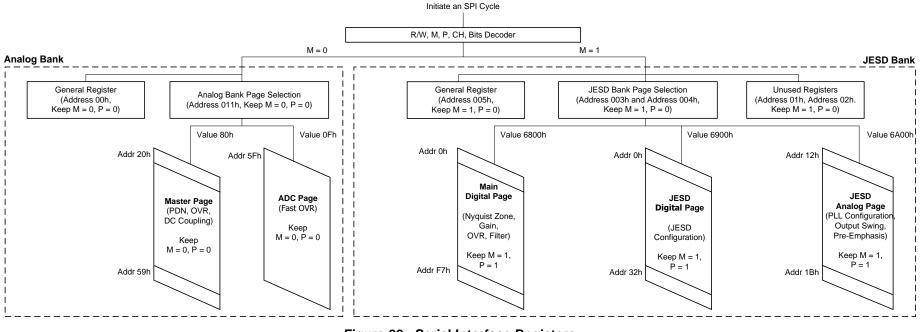


Figure 82. Serial Interface Registers



#### 8.5.1 Detailed Register Information

The ADS54J20 contains two main SPI banks. The analog SPI bank provides access to the ADC analog blocks and the digital SPI bank controls the interleaving engine and anything related to the JESD204B serial interface. The analog SPI bank is divided into two pages (master and ADC) and the digital SPI bank is divided into three pages (main digital, JESD digital, and JESD analog). Table 15 lists a register map for the ADS54J20.

REGISTER ADDRESS				REGIST	ER DATA			
A[11:0] (Hex)	7	6	5	4	3	2	1	0
GENERAL REG	ISTERS							
0	RESET	0	0	0	0	0	0	RESET
3		1 1		JESD BANK	PAGE SEL[7:0]		1	I
4					PAGE SEL[15:8]			
5	0	0	0	0	0	0	0	DISABLE BROADCAST
11		1 1		ANALOG BA	NK PAGE SEL		1	I
MASTER PAGE	(80h)							
20		PDN AD	OC CHA			PDN A	ADC CHB	
21	PDN BUF	FER CHB	PDN BUF	FER CHA	0	0	0	0
23		PDN AD	OC CHA		1	PDN A	ADC CHB	1
24	PDN BUF	FER CHB	PDN BUF	FER CHA	0	0	0	0
26	GLOBAL PDN	OVERRIDE PDN PIN	PDN MASK SEL	0	0	0	0	0
4F	0	0	0	0	0	0	0	EN INPUT DC COUPLING
53	0	MASK SYSREF	0	0	0	0	EN SYSREF DC COUPLING	SET SYSREF
54	ENABLE MANUAL SYSREF	0	0	0	0	0	0	0
55	0	0	0	PDN MASK	0	0	0	0
59	FOVR CHB	0	ALWAYS WRITE 1	0	0	0	0	0
ADC PAGE (0F	ı)			<u>.</u>	• •			<u>.</u>
5F				FOVR THRE	SHOLD PROG			
MAIN DIGITAL	PAGE (6800h)							
0	0	0	0	0	0	0	0	PULSE RESET
41	0	0	DECFIL MODE[3]	DECFIL EN	0		DECFIL MODE[2:0	)]
42	0	0	0	0	0		NYQUIST ZONE	
43	0	0	0	0	0	0	0	FORMAT SEL
44	0				DIGITAL GAIN			
4B	0	0	FORMAT EN	0	0	0	0	0
4D	0	0	0	0	DEC MODE EN	0	0	0
4E	CTRL NYQUIST	0	0	0	0	0	0	0
52	BUS_ REORDER EN1	0	0	0	0	0	0	DIG GAIN EN
72	0	0	0	0	BUS_ REORDER EN2	0	0	0
AB	0	0	0	0	0	0	0	LSB SEL EN
AD	0	0	0	0	0	0	LSB S	ELECT
F7	0	0	0	0	0	0	0	DIG RESET

#### Table 15. Register Map

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REGISTER ADDRESS				REGISTI	ER DATA			
A[11:0] (Hex)	7	6	5	4	3	2	1	0
JESD DIGITAL	PAGE (6900h)							
0	CTRL K	0	0	TESTMODE EN	FLIP ADC DATA	LANE ALIGN	FRAME ALIGN	TX LINK DIS
1	SYNC REG	SYNC REG EN		JESD FILTER			JESD MODE	
2	LINI	K LAYER TESTMO	0	0	0			
3	FORCE LMFC COUNT							
5	SCRAMBLE EN							0
6	0	0	0		FRAME	S PER MULTI FR	AME (K)	
7	0	0	0	0	SUBCLASS	0	0	0
16	1	0	0	LANE SHARE	0	0	0	0
31				DA_BUS_RE	EORDER[7:0]			
32				DB_BUS_RE	EORDER[7:0]			
JESD ANALOG	PAGE (6A00h)							
12			SEL EMI	P LANE 1			0	0
13			SEL EMI	P LANE 0			0	0
14			SEL EMI	P LANE 2			0	0
15		SEL EMP LANE 3						0
16	0	0 0 0 0 0					JESD PL	L MODE
17	0	PLL RESET	0	0	0	0	0	0
1A	0	0	0	0	0	0	FOVR CHA	0
1B		JESD SWING		0	FOVR CHA EN	0	0	0

# Table 15. Register Map (continued)

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#### 8.5.2 Example Register Writes

This section provides three different example register writes. Table 16 describes a global power-down register write, Table 17 describes the register writes when the default lane setting (eight active lanes per device) is changed to four active lanes (LMFS = 4211), and Table 18 describes the register writes for 2X decimation with four active lanes (LMFS = 4222).

ADDRESS (Hex)	DATA (Hex)	COMMENT
0-011h	80h	Set the master page
0-026h	C0h	Set the global power-down

#### Table 16. Global Power Down

ADDRESS (Hex)	DATA (Hex)	COMMENT
4-004h	69h	Select the JESD digital page
4-003h	00h	Select the JESD digital page
6-001h	02h	Select the digital to 40X mode
4-004h	6Ah	Select the JESD analog page
6-016h	02h	Set the SerDes PLL to 40X mode

#### Table 17. Two Lanes per Channel Mode (LMFS = 4211)

#### Table 18. 2X Decimation (LPF for Both Channels) with Four Active Lanes (LMFS = 4222)

ADDRESS (Hex)	DATA (Hex)	COMMENT
4-004h	68h	Select the main digital page (6800h)
4-003h	00h	Select the main digital page (6800h)
6-041h	12h	Set decimate-by-2 (low-pass filter)
6-04Dh	08h	Enable decimation filter control
6-072h	08h	BUS_REORDER EN2
6-052h	80h	BUS_REORDER EN1
6-000h	01h	Dules the DLU SE DESET hit (as that register writes to the main digital page as into effect)
6-000h	00h	Pulse the PULSE RESET bit (so that register writes to the main digital page go into effect).
4-004h	69h	Select the JESD digital page (6900h)
4-003h	00h	Select the JESD digital page (6900h)
6-031h	0Ah	Output bus reorder for channel A
6-032h	0Ah	Output bus reorder for channel B
6-001h	31h	Program the JESD MODE and JESD FILTER register bits for LMFS = 4222.

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#### 8.5.3 Register Descriptions

# 8.5.3.1 General Registers

# 8.5.3.1.1 Register 0h (address = 0h)

### Figure 83. Register 0h

7	6	5	4	3	2	1	0
RESET	0	0	0	0	0	0	RESET
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: W = Write only; -n = value after reset

# Table 19. Register 0h Field Descriptions

Bit	Field	Туре	Reset	Description
7	RESET	W	0h	0 = Normal operation 1 = Internal software reset, clears back to 0
6-1	0	W	0h	Must write 0
0	RESET	W	0h	0 = Normal operation 1 = Internal software reset, clears back to 0

# 8.5.3.1.2 Register 3h (address = 3h)

# Figure 84. Register 3h

7	6	5	4	3	2	1	0
			JESD BANK F	PAGE SEL[7:0]			
			R/W	V-0h			

LEGEND: R/W = Read/Write; -n = value after reset

# Table 20. Register 3h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	JESD BANK PAGE SEL[7:0]	R/W	Oh	Program these bits to access the desired page in the JESD bank. 6800h = Main digital page selected 6900h = JESD digital page selected 6A00h = JESD analog page selected

#### 8.5.3.1.3 Register 4h (address = 4h)

# Figure 85. Register 4h

7	6	5	4	3	2	1	0		
	JESD BANK PAGE SEL[15:8]								
			R/W	/-0h					

LEGEND: R/W = Read/Write; -n = value after reset

# Table 21. Register 4h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	JESD BANK PAGE SEL[15:8]	R/W	Oh	Program these bits to access the desired page in the JESD bank. 6800h = Main digital page selected 6900h = JESD digital page selected 6A00h = JESD analog page selected



#### 8.5.3.1.4 Register 5h (address = 5h)

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# Figure 86. Register 5h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	DISABLE BROADCAST
W-0h	R/W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

#### Table 22. Register 5h Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	DISABLE BROADCAST	R/W	0h	0 = Normal operation; channel A and B are programmed as a pair 1 = Channel A and B can be individually programmed based on the CH bit

# 8.5.3.1.5 Register 11h (address = 11h)

# Figure 87. Register 11h

7	6	5	4	3	2	1	0
ANALOG PAGE SELECTION							
			R/V	V-0h			

LEGEND: R/W = Read/Write; -n = value after reset

## Table 23. Register 11h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	ANALOG BANK PAGE SEL	R/W	0h	Program these bits to access the desired page in the analog bank. Master page = 80h ADC page = 0Fh

#### 8.5.3.2 Master Page (080h) Registers

### 8.5.3.2.1 Register 20h (address = 20h), Master Page (080h)

# Figure 88. Register 20h

7	6	5	4	3	2	1	0
	PDN AD	DC CHA			PDN AD	OC CHB	
	R/W	/-0h			R/W	/-0h	

LEGEND: R/W = Read/Write; -n = value after reset

# Table 24. Registers 20h Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	PDN ADC CHA	R/W	0h	There are two power-down masks that are controlled via the
3-0	PDN ADC CHB	R/W	Oh	<ul> <li>PDN mask register bit in address 55h. The power-down mask 1 or mask 2 are selected via register bit 5 in address 26h.</li> <li>Power-down mask 1: addresses 20h and 21h.</li> <li>Power-down mask 2: addresses 23h and 24h.</li> <li>OFh = Power-down CHB only.</li> <li>F0h = Power-down CHA only.</li> <li>FFh = Power-down both.</li> </ul>

Bit

7-6

5-4

Field

PDN BUFFER CHB

PDN BUFFER CHA

# 8.5.3.2.2 Register 21h (address = 21h), Master Page (080h)

# 3-0 0 W 0h

# 8.5.3.2.3 Register 23h (address = 23h), Master Page (080h)

#### Figure 90. Register 23h

7	6	5	4	3	2	1	0
	PDN AD	OC CHA			PDN AD	C CHB	
	R/W	/-0h			R/W	/-0h	

LEGEND: R/W = Read/Write; -n = value after reset

#### Table 26. Register 23h Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	PDN ADC CHA	R/W	0h	There are two power-down masks that are controlled via the
3-0	PDN ADC CHB	R/W	Oh	<ul> <li>PDN mask register bit in address 55h. The power-down mask 1 or mask 2 are selected via register address 26h, bit 5.</li> <li>Power-down mask 1: addresses 20h and 21h.</li> <li>Power-down mask 2: addresses 23h and 24h.</li> <li>0Fh = Power-down CHB only.</li> <li>F0h = Power-down CHA only.</li> <li>FFh = Power-down both.</li> </ul>

# Figure 89. Register 21h

7	6	5	4	3	2	1	0
PDN BU	IFFER CHB	PDN BUF	FFER CHA	0	0	0	0
R/	/W-0h	R/W-0h		W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 25. Register 21h Field Descriptions

Description

cores.

PDN BUFFER CHx:

01-10 = Do not use.

Must write 0.

There are two power-down masks that are controlled via the PDN mask register bit in address 55h. The power-down mask 1

There are two buffers per channel. One buffer drives two ADC

or mask 2 are selected via register address 26h, bit 5. Power-down mask 1: addresses 20h and 21h. Power-down mask 2: addresses 23h and 24h.

00 = Both buffers of a channel are active. 11 = Both buffers are powered down.

Reset

0h

0h

Туре

R/W

R/W

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# 8.5.3.2.4 Register 24h (address = 24h), Master Page (080h)

# Figure 91. Register 24h

7	6	5	4	3	2	1	0
PDN BU	FFER CHB	PDN BUFFER CHA		0	0	0	0
R/	R/W-0h R/W-0h		W-0h	W-0h	W-0h	W-0h	

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 27. Register 24h Field Descriptions

Bit	Field	Туре	Reset	Description
7-6	PDN BUFFER CHB	R/W	0h	There are two power-down masks that are controlled via the
5-4	PDN BUFFER CHA	R/W	Oh	<ul> <li>PDN mask register bit in address 55h. The power-down mask 1 or mask 2 are selected via register address 26h, bit 5.</li> <li>Power-down mask 1: addresses 20h and 21h.</li> <li>Power-down mask 2: addresses 23h and 24h.</li> <li>Power-down mask 2: addresses 23h and 24h.</li> <li>There are two buffers per channel. One buffer drives two ADC cores.</li> <li>PDN BUFFER CHx:</li> <li>00 = Both buffers of a channel are active.</li> <li>11 = Both buffers are powered down.</li> <li>01–10 = Do not use.</li> </ul>
3-0	0	W	0h	Must write 0.

# 8.5.3.2.5 Register 26h (address = 26h), Master Page (080h)

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# Figure 92. Register 26h

7	6	5	4	3	2	1	0
GLOBAL PDN	OVERRIDE PDN PIN	PDN MASK SEL	0	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 28. Register 26h Field Descriptions

	Í.			•
Bit	Field	Туре	Reset	Description
7	GLOBAL PDN	R/W	Oh	Bit 6 (OVERRIDE PDN PIN) must be set before this bit can be programmed. 0 = Normal operation 1 = Global power-down via the SPI
6	OVERRIDE PDN PIN	R/W	Oh	This bit ignores the power-down pin control. 0 = Normal operation 1 = Ignores inputs on the power-down pin
5	PDN MASK SEL	R/W	0h	This bit selects power-down mask 1 or mask 2. 0 = Power-down mask 1 1 = Power-down mask 2
4-0	0	W	0h	Must write 0

# 8.5.3.2.6 Register 4Fh (address = 4Fh), Master Page (080h)

# Figure 93. Register 4Fh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	EN INPUT DC COUPLING
W-0h	R/W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 29. Register 4Fh Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	EN INPUT DC COUPLING	R/W	0h	This bit enables dc-coupling between the analog inputs and the driver by changing the internal biasing resistor between the analog inputs and VCM from 600 $\Omega$ to 5 k $\Omega$ . 0 = The dc-coupling support is disabled 1 = The dc-coupling support is enabled

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# 8.5.3.2.7 Register 53h (address = 53h), Master Page (080h)

# Figure 94. Register 53h

7	6	5	4	3	2	1	0
0	MASK SYSREF	0	0	0	0	EN SYSREF DC COUPLING	SET SYSREF
W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 30. Register 53h Field Descriptions

		•		•
Bit	Field	Туре	Reset	Description
7	0	W	0h	Must write 0
6	MASK SYSREF	R/W	0h	0 = Normal operation 1 = Ignores the SYSREF input
5-2	0	W	0h	Must write 0
1	EN SYSREF DC COUPLING	R/W	Oh	This bit enables a higher common-mode voltage input on the SYSREF signal (up to 1.6 V). 0 = Normal operation 1 = Enables a higher SYSREF common-mode voltage support
0	SET SYSREF	R/W	0h	0 = Set SYSREF low 1 = Set SYSREF high

#### 8.5.3.2.8 Register 54h (address = 54h), Master Page (080h)

# Figure 95. Register 54h

7	6	5	4	3	2	1	0
ENABLE MANUAL SYSREF	0	0	0	0	0	0	0
R/W-0h	W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 31. Register 54h Field Descriptions

Bit	Field	Туре	Reset	Description
7	ENABLE MANUAL SYSREF	R/W	0h	This bit enables manual SYSREF
6-0	0	W	0h	Must write 0

# 8.5.3.2.9 Register 55h (address = 55h), Master Page (080h)

# Figure 96. Register 55h

7	6	5	4	3	2	1	0
0	0	0	PDN MASK	0	0	0	0
W-0h	W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 32. Register 55h Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	0	W	0h	Must write 0
4	PDN MASK	R/W	0h	This bit enables power-down via a register bit. 0 = Normal operation 1 = Power-down is enabled by powering down the internal blocks as specified in the selected power-down mask
3-0	0	W	0h	Must write 0

# 8.5.3.2.10 Register 59h (address = 59h), Master Page (080h)

# Figure 97. Register 59h

7	6	5	4	3	2	1	0
FOVR CHB	0	ALWAYS WRITE 1	0	0	0	0	0
W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 33. Register 59h Field Descriptions

Bit	Field	Туре	Reset	Description
7	FOVR CHB	W	0h	This bit outputs the FOVR signal for channel B on the SDOUT pin. 0 = Normal operation 1 = The FOVR signal is available on the SDOUT pin
6	0	W	0h	Must write 0
5	ALWAYS WRITE 1	R/W	0h	Must write 1
4-0	0	W	0h	Must write 0

# 8.5.3.3 ADC Page (0Fh) Register

## 8.5.3.3.1 Register 5F (addresses = 5F), ADC Page (0Fh)

## Figure 98. Register 5F

7	6	5	4	3	2	1	0
			FOVR THRES	SHOLD PROG			
			R/W	′-E3h			

LEGEND: R/W = Read/Write; -n = value after reset

# Table 34. Register 5F Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	FOVR THRESHOLD PROG	R/W		Program the fast OVR thresholds together for channel A and B, as described in the <i>Overrange Indication</i> section.

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## 8.5.3.4 Main Digital Page (6800h) Registers

### 8.5.3.4.1 Register 0h (address = 0h), Main Digital Page (6800h)

### Figure 99. Register 0h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	PULSE RESET
W-0h	R/W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Table 35. Register 0h Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	PULSE RESET	R/W	Oh	This bit must be pulsed after power-up or after configuring registers in the main digital page of the JESD bank. Any register bits in the main digital page (6800h) take effect only after this bit is pulsed; see the <i>Start-Up Sequence</i> section for the correct sequence. 0 = Normal operation $0 \rightarrow 1 \rightarrow 0 = This bit is pulsed$

#### 8.5.3.4.2 Register 41h (address = 41h), Main Digital Page (6800h)

# Figure 100. Register 41h

7	6	5	4	3	2	1	0
0	0	DECFIL MODE[3]	DECFIL EN	0	E	DECFIL MODE[2	:0]
W-0h	W-0h	R/W-0h	R/W-0h	W-0h		R/W-0h	

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

#### Table 36. Register 41h Field Descriptions

Bit	Field	Туре	Reset	Description
7-6	0	W	0h	Must write 0
5	DECFIL MODE[3]	R/W	0h	This bit selects the decimation filter mode. Table 37 lists the bit settings. The decimation filter control (DEC MODE EN, register 4Dh, bit 3) and decimation filter enable (DECFIL EN, register 41h, bit 4) must be enabled.
4	DECFIL EN	R/W	0h	This bit enables the digital decimation filter. 0 = Normal operation, full rate output 1 = Digital decimation enabled
3	0	W	0h	Must write 0
2-0	DECFIL MODE[2:0]	R/W	0h	These bits select the decimation filter mode. Table 37 lists the bit settings. The decimation filter control (DEC MODE EN, register 4Dh, bit 3) and decimation filter enable (DECFIL EN, register 41h, bit 4) must be enabled.

### Table 37. DECFIL MODE Bit Settings

BITS (5, 2-0)	FILTER MODE	DECIMATION
0000	Band-pass filter centered on $3 \times f_S / 16$	4X
0100	Band-pass filter centered on 5 × $f_S$ / 16	4X
1000	Band-pass filter centered on $1 \times f_S / 16$	4X
1100	Band-pass filter centered on $7 \times f_S / 16$	4X
0010	Low-pass filter	2X
0110	High-pass filter	2X
0011	Low-pass filter with f <sub>S</sub> / 4 mixer	4X (IQ)

## 8.5.3.4.3 Register 42h (address = 42h), Main Digital Page (6800h)

# Figure 101. Register 42h

7	6	5	4	3	2	2 1	
0	0	0	0	0	NYQUIST ZONE		
W-0h	W-0h	W-0h	W-0h	W-0h		R/W-0h	

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

#### Table 38. Register 42h Field Descriptions

				-
Bit	Field	Туре	Reset	Description
7-3	0	W	0h	Must write 0
2-0	NYQUIST ZONE	R/W	Oh	The Nyquist zone must be selected for proper interleaving correction. Nyquist refers to the device clock / 2. For a 1.0- GSPS device clock, the Nyquist frequency is 500 MHz. The CTRL NYQUIST register bit (register 4Eh, bit 7) must also be set. 000 = First Nyquist zone (0 MHz to 500 MHz) 001 = Second Nyquist zone (500 MHz to 1000 MHz) 010 = Third Nyquist zone (1000 MHz to 1500 MHz) All others = Not used

## 8.5.3.4.4 Register 43h (address = 43h), Main Digital Page (6800h)

# Figure 102. Register 43h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	FORMAT SEL
W-0h	R/W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Table 39. Register 43h Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	FORMAT SEL	R/W	Oh	This bit changes the output format. Set the FORMAT EN bit to enable control using this bit. 0 = Twos complement 1 = Offset binary

# 8.5.3.4.5 Register 44h (address = 44h), Main Digital Page (6800h)

#### Figure 103. Register 44h

7	6	5	4	3	2	1	0
0				DIGITAL GAIN			
R/W-0h				R/W-0h			

LEGEND: R/W = Read/Write; -n = value after reset

# Table 40. Register 44h Field Descriptions

Bit	Field	Туре	Reset	Description
7	0	R/W	0h	Must write 0
6-0	DIGITAL GAIN	R/W	Oh	These bits set the digital gain setting. The DIG GAIN EN register bit (register 52h, bit 0) must be enabled to use these bits. Gain in dB = 20log (digital gain / 32). 7Fh = 127 equals a digital gain of 9.5 dB.



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# 8.5.3.4.6 Register 4Bh (address = 4Bh), Main Digital Page (6800h)

# Figure 104. Register 4Bh

7	6	5	4	3	2	1	0
0	0	FORMAT EN	0	0	0	0	0
W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 41. Register 4Bh Field Descriptions

Bit	Field	Туре	Reset	Description
7-6	0	W	0h	Must write 0
5	FORMAT EN	R/W	0h	This bit enables control for data format selection using the FORMAT SEL register bit. 0 = Default, output is in twos complement format 1 = Output is in offset binary format after the FORMAT SEL bit is set
4-0	0	W	0h	Must write 0

# 8.5.3.4.7 Register 4Dh (address = 4Dh), Main Digital Page (6800h)

# Figure 105. Register 4Dh

7	6	5	4	3	2	1	0
0	0	0	0	DEC MOD EN	0	0	0
W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 42. Register 4Dh Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	0	W	0h	Must write 0
3	DEC MOD EN	R/W	Oh	This bit enables control of the decimation filter mode via the DECFIL MODE[3:0] register bits. 0 = Default 1 = Decimation mode control is enabled
2-0	0	W	0h	Must write 0

# 8.5.3.4.8 Register 4Eh (address = 4Eh), Main Digital Page (6800h)

# Figure 106. Register 4Eh

7	6	5	4	3	2	1	0
CTRL NYQUIST	0	0	0	0	0	0	0
R/W-0h	W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

#### Table 43. Register 4Eh Field Descriptions

Bit	Field	Туре	Reset	Description
7	CTRL NYQUIST	R/W	0h	This bit enables selecting the Nyquist zone using register 42h, bits 2-0. 0 = Selection disabled 1 = Selection enabled
6-0	0	W	0h	Must write 0

### 8.5.3.4.9 Register 52h (address = 52h), Main Digital Page (6800h)

#### Figure 107. Register 52h

7	6	5	4	3	2	1	0
BUS_REORDER EN1	0	0	0	0	0	0	DIG GAIN EN
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 44. Register 52h Field Descriptions

Bit	Field	Туре	Reset	Description
7	BUS_REORDER EN1	R/W	0h	Must write 1 in DDC mode only.
6-1	0	W	0h	Must write 0
0	DIG GAIN EN	R/W	0h	This bit enables selecting the digital gain for register 44h. 0 = Digital gain disabled 1 = Digital gain enabled

## 8.5.3.4.10 Register 72h (address = 72h), Main Digital Page (6800h)

# Figure 108. Register 72h

7	6	5	4	3	2	1	0
0	0	0	0	BUS_REORDER EN2	0	0	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 45. Register 72h Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	0	W	0h	Must write 0
3	BUS_REORDER EN2	R/W	0h	Must write 1 in DDC mode only.
2-0	0	W	0h	Must write 0

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# 8.5.3.4.11 Register ABh (address = ABh), Main Digital Page (6800h)

# Figure 109. Register ABh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	LSB SEL EN
W-0h	R/W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 46. Register ABh Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	LSB SEL EN	R/W	0h	This bit enables control for the LSB SELECT register bit. 0 = Default 1 = LSB of the 16-bit data (12-bit ADC data padded with four 0s as the LSBs) can be programmed as fast OVR using the LSB SELECT register bit.

#### 8.5.3.4.12 Register ADh (address = ADh), Main Digital Page (6800h)

## Figure 110. Register ADh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	LSB SEL	ECT
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 47. Register ADh Field Descriptions

Bit	Field	Туре	Reset	Description
7-2	0	W	0h	Must write 0
1-0	LSB SELECT	R/W	Oh	These bits enable the output of the FOVR flag instead of the output data LSB. Ensure that the LSB SEL EN register bit is set to 1. 00 = Output is 16-bit data (12-bit ADC data padded with four 0s as the LSBs) 11 = The LSB of the 16-bit output data is replaced by the FOVR information for each channel

#### 8.5.3.4.13 Register F7h (address = F7h), Main Digital Page (6800h)

# Figure 111. Register F7h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	DIG RESET
W-0h							

LEGEND: W = Write only; -n = value after reset

# Table 48. Register F7h Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	DIG RESET	W	0h	This bit is the self-clearing reset for the digital block and does not include interleaving correction. 0 = Normal operation 1 = Digital reset

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# 8.5.3.5 JESD Digital Page (6900h) Registers

# 8.5.3.5.1 Register 0h (address = 0h), JESD Digital Page (6900h)

# Figure 112. Register 0h

7	6	5	4	3	2	1	0
CTRL K	0	0	TESTMODE EN	FLIP ADC DATA	LANE ALIGN	FRAME ALIGN	TX LINK DIS
R/W-0h	W-0h	W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Bit	Field	Туре	Reset	Description
7	CTRL K	R/W	0h	This bit is the enable bit for a number of frames per multiframe. 0 = Default is five frames per multiframe 1 = Frames per multiframe can be set in register 06h
6-5	0	W	0h	Must write 0
4	TESTMODE EN	R/W	0h	This bit generates the long transport layer test pattern mode, as per section 5.1.6.3 of the JESD204B specification. 0 = Test mode disabled 1 = Test mode enabled
3	FLIP ADC DATA	R/W	0h	<ul><li>0 = Normal operation</li><li>1 = Output data order is reversed: MSB to LSB.</li></ul>
2	LANE ALIGN	R/W	0h	This bit inserts the lane alignment character (K28.3) for the receiver to align to the lane boundary, as per section 5.3.3.5 of the JESD204B specification. 0 = Normal operation 1 = Inserts lane alignment characters
1	FRAME ALIGN	R/W	0h	This bit inserts the lane alignment character (K28.7) for the receiver to align to the lane boundary, as per section 5.3.3.5 of the JESD204B specification. 0 = Normal operation 1 = Inserts frame alignment characters
0	TX LINK DIS	R/W	0h	This bit disables sending the initial link alignment (ILA) sequence when SYNC is deasserted. 0 = Normal operation 1 = ILA disabled



# 8.5.3.5.2 Register 1h (address = 1h), JESD Digital Page (6900h)

# Figure 113. Register 1h

7	6	5	4	3	2	1	0
SYNC REG	SYNC REG EN		JESD FILTER			JESD MODE	
R/W-0h	R/W-0h		R/W-0h			R/W-01h	

LEGEND: R/W = Read/Write; -n = value after reset

Table 50. Register 1h	Field Descriptions
-----------------------	--------------------

Bit	Field	Туре	Reset	Description
7	SYNC REG	R/W	Oh	This bit is the register control for the sync request. 0 = Normal operation 1 = ADC output data are replaced with K28.5 characters; the SYNC REG EN register bit must also be set to 1
6	SYNC REG EN	R/W	Oh	This bit enables register control for the sync request. 0 = Use the SYNC pin for sync requests 1 = Use the SYNC REG register bit for sync requests
5-3	JESD FILTER	R/W	Oh	These bits and the JESD MODE bits set the correct LMFS configuration for the JESD interface. The JESD FILTER setting must match the configuration in the decimation filter page. 000 = Filter bypass mode See Table 51 for valid combinations for register bits JESD FILTER along with JESD MODE.
2-0	JESD MODE	R/W	01h	These bits select the number of serial JESD output lanes per ADC. The JESD PLL MODE register bit located in the JESD analog page must also be set accordingly. 001 = Default after reset(Eight active lanes) See Table 51 for valid combinations for register bits JESD FILTER along with JESD MODE.

# Table 51. Valid Combinations for JESD FILTER and JESD MODE Bits

REGISTER BIT JESD FILTER	REGISTER BIT JESD MODE	DECIMATION FACTOR	NUMBER OF ACTIVE LANES PER DEVICE
000	100	No decimation	Four lanes are active
000	010	No decimation	Four lanes are active
000	001	No decimation (default after reset)	Eight lanes are active
111	001	4X (IQ)	Four lanes are active
110	001	2X	Four lanes are active
110	010	2X	Two lanes are active
100	001	4X	Two lanes are active
111	010	4X (IQ)	Two lanes are active
100	010	4X	One lane is active

# 8.5.3.5.3 Register 2h (address = 2h), JESD Digital Page (6900h)

# Figure 114. Register 2h

7	6	5	4	3	2	1	0
LINK	LAYER TEST	NODE	LINK LAYER RPAT	LMFC MASK RESET	0	0	0
	R/W-0h		R/W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 52. Register 2h Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	LINK LAYER TESTMODE	R/W	Oh	These bits generate a pattern as per section 5.3.3.8.2 of the JESD204B document. 000 = Normal ADC data 001 = D21.5 (high-frequency jitter pattern) 010 = K28.5 (mixed-frequency jitter pattern) 011 = Repeat initial lane alignment (generates a K28.5 character and continuously repeats lane alignment sequences) 100 = 12-octet RPAT jitter pattern All others = Not used
4	LINK LAYER RPAT	R/W	Oh	This bit changes the running disparity in the modified RPAT pattern test mode (only when the link layer test mode = 100). 0 = Normal operation 1 = Changes disparity
3	LMFC MASK RESET	R/W	Oh	This bit masks the LMFC reset coming to the digital block. 0 = LMFC reset is not masked 1 = Ignore the LMFC reset request
2-0	0	W	0h	Must write 0

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# 8.5.3.5.4 Register 3h (address = 3h), JESD Digital Page (6900h)

# Figure 115. Register 3h

7	6	5	4	3	2	1	0
FORCE LMFC COUNT		LMFC COUNT INIT				RELEASE	ILANE SEQ
R/W-0h		R/W-0h				R/\	V-0h

LEGEND: R/W = Read/Write; -n = value after reset

## Table 53. Register 3h Field Descriptions

Bit	Field	Туре	Reset	Description
7	FORCE LMFC COUNT	R/W	0h	This bit forces the LMFC count. 0 = Normal operation 1 = Enables using a different starting value for the LMFC counter
6-2	MASK SYSREF	R/W	0h	When SYSREF transmits to the digital block, the LMFC count resets to 0 and K28.5 stops transmitting when the LMFC count reaches 31. The initial value that the LMFC count resets to can be set using LMFC COUNT INIT. In this manner, the receiver can be synchronized early because the LANE ALIGNMENT SEQUENCE is received early. The FORCE LMFC COUNT register bit must be enabled.
1-0	RELEASE ILANE SEQ	R/W	0h	These bits delay the generation of the lane alignment sequence by 0, 1, 2, or 3 multiframes after the code group synchronization. 00 = 0 01 = 1 10 = 2 11 = 3

#### 8.5.3.5.5 Register 5h (address = 5h), JESD Digital Page (6900h)

## Figure 116. Register 5h

7	6	5	4	3	2	1	0
SCRAMBLE EN	0	0	0	0	0	0	0
R/W-Undefined	W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 54. Register 5h Field Descriptions

Bit	Field	Туре	Reset	Description
7	SCRAMBLE EN	R/W	Undefined	This bit is the scramble enable bit in the JESD204B interface. 0 = Scrambling disabled 1 = Scrambling enabled
6-0	0	W	0h	Must write 0

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# 8.5.3.5.6 Register 6h (address = 6h), JESD Digital Page (6900h)

# Figure 117. Register 6h

7	6	5	4	3	2	1	0
0	0	0		FRAME	S PER MULTI FR	AME (K)	
W-0h	W-0h	W-0h			R/W-8h		

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

#### Table 55. Register 6h Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	0	W	0h	Must write 0
4-0	FRAMES PER MULTI FRAME (K)	R/W	8h	These bits set the number of multiframes. Actual K is the value in hex + 1 (that is, 0Fh is $K = 16$ ).

## 8.5.3.5.7 Register 7h (address = 7h), JESD Digital Page (6900h)

#### Figure 118. Register 7h

7	6	5	4	3	2	1	0
0	0	0	0	SUBCLASS	0	0	0
W-0h	W-0h	W-0h	W-0h	R/W-1h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

#### Table 56. Register 7h Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	0	W	0h	Must write 0
3	SUBCLASS	R/W	1h	This bit sets the JESD204B subclass. 000 = Subclass 0 is backward compatible with JESD204A 001 = Subclass 1 deterministic latency using the SYSREF signal
2-0	0	W	0h	Must write 0

### 8.5.3.5.8 Register 16h (address = 16h), JESD Digital Page (6900h)

# Figure 119. Register 16h

7	6	5	4	3	2	1	0
1	0	0	LANE SHARE	0	0	0	0
W-1h	W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 57. Register 16h Field Descriptions

Bit	Field	Туре	Reset	Description
7	1	W	1h	Must write 1
6-5	0	W	0h	Must write 0
4	LANE SHARE	R/W	0h	When using decimate-by-4, the data of both channels are output over one lane (LMFS = 1241). 0 = Normal operation (each channel uses one lane) 1 = Lane sharing is enabled, both channels share one lane (LMFS = 1241)
3-0	0	W	0h	Must write 0



# 8.5.3.5.9 Register 31h (address = 31h), JESD Digital Page (6900h)

# Figure 120. Register 31h

7	6	5	4	3	2	1	0			
DA_BUS_REORDER[7:0]										
	R/W-0h									

LEGEND: R/W = Read/Write; -n = value after reset

### Table 58. Register 31h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	DA_BUS_REORDER[7:0]	R/W		Use these bits to program output connections between data streams and output lanes in decimate-by-2 and decimate-by-4 mode. Table 14 lists the supported combinations of these bits.

#### 8.5.3.5.10 Register 32h (address = 32h), JESD Digital Page (6900h)

# Figure 121. Register 32h

7	6	5	4	3	2	1	0			
DB_BUS_REORDER[7:0]										
	R/W-0h									

LEGEND: R/W = Read/Write; -n = value after reset

# Table 59. Register 32h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	DB_BUS_REORDER[7:0]	R/W		Use these bits to program output connections between data streams and output lanes in decimate-by-2 and decimate-by-4 mode. Table 14 lists the supported combinations of these bits.

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# 8.5.3.6 JESD Analog Page (6A00h) Registers

# 8.5.3.6.1 Registers 12h-5h (addresses = 12h-5h), JESD Analog Page (6A00h)

# Figure 122. Register 12h

7	6	5	4	3	2	1	0
SEL EMP LANE 1							0
	R/W-0h						W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Figure 123. Register 13h

7	6	5	4	3	2	1	0
	SEL EMP LANE 0						
	R/W-0h						W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Figure 124. Register 14h

7	6	5	4	3	2	1	0
	SEL EMP LANE 2						
	R/W-0h						W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Figure 125. Register 15h

7	6	5	4	3	2	1	0
	7         6         5         4         3         2           SEL EMP LANE 3					0	0
		R/W	/-0h			W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 60. Registers 12h-15h Field Descriptions

Bit	Field	Туре	Reset	Description
7-2	SEL EMP LANE x (where x = 1, 0, 2, or 3)	R/W	Oh	These bits select the amount of de-emphasis for the JESD output transmitter. The de-emphasis value in decibels (dB) is measured as the ratio between the peak value after the signal transition to the settled value of the voltage in one bit period. 000000 = 0  dB 000001 = -1  dB 000011 = -2  dB 000111 = -4.1  dB 001111 = -6.2  dB 011111 = -8.2  dB 111111 = -11.5  dB
1-0	0	W-0h	0h	Must write 0

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# 8.5.3.6.2 Register 16h (address = 16h), JESD Analog Page (6A00h)

# Figure 126. Register 16h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	JESD PLL MODE	
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-	0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 61. Register 16h Field Descriptions

Bit	Field	Туре	Reset	Description
7-2	0	W	0h	Must write 0
1-0	JESD PLL MODE	R/W	Oh	These bits select the JESD PLL multiplication factor and must match the JESD MODE setting. 00 = 20X mode 01 = Not used 10 = 40X mode 11 = Not used See Table 14 for a programming summary of the DDC modes and JESD link configuration.

### 8.5.3.6.3 Register 17h (address = 17h), JESD Analog Page (6A00h)

# Figure 127. Register 17h

7	6	5	4	3	2	1	0
0	PLL RESET	0	0	0	0	0	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

#### Table 62. Register 17h Field Descriptions

Bit	Field	Туре	Reset	Description
7	0	W	0h	Must write 0
6	PLL RESET	R/W		Pulse this bit after powering up the device; see Table 65. 0 = Default $0 \rightarrow 1 \rightarrow 0 = The PLL RESET bit is pulsed.$
5-0	0	W	0h	Must write 0

# 8.5.3.6.4 Register 1Ah (address = 1Ah), JESD Analog Page (6A00h)

# Figure 128. Register 1Ah

7	6	5	4	3	2	1	0
0	0	0	0	0	0	FOVR CHA	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 63. Register 1Ah Field Descriptions

Bit	Field	Туре	Reset	Description
7-2	0	W	0h	Must write 0
1	FOVR CHA	R/W	0h	This bit outputs the FOVR signal for channel A on the PDN pin. FOVR CHA EN (register 1Bh, bit 3) must be enabled for this bit to function. 0 = Normal operation 1 = The FOVR signal of channel A is available on the PDN pin
0	0	W	0h	Must write 0

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# 8.5.3.6.5 Register 1Bh (address = 1Bh), JESD Analog Page (6A00h)

# Figure 129. Register 1Bh

7	6	5	4	3	2	1	0
	JESD SWING		0	FOVR CHA EN	0	0	0
	R/W-0h		W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 64. Register 1Bh Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	JESD SWING	R/W	Oh	These bits select the output amplitude $V_{OD}$ (mV <sub>PP</sub> ) of the JESD transmitter (for all lanes). 0 = 860 mV <sub>PP</sub> 1 = 810 mV <sub>PP</sub> 2 = 770 mV <sub>PP</sub> 3 = 745 mV <sub>PP</sub> 4 = 960 mV <sub>PP</sub> 5 = 930 mV <sub>PP</sub> 6 = 905 mV <sub>PP</sub> 7 = 880 mV <sub>PP</sub>
4	0	W	0h	Must write 0
3	FOVR CHA EN	R/W	0h	This bit enables overwrites of the PDN pin with the FOVR signal from channel A. 0 = Normal operation 1 = PDN is overwritten
2-0	0	W	0h	Must write 0

# 9 Application and Implementation

# NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

# 9.1 Application Information

# 9.1.1 Start-Up Sequence

The steps described in Table 65 are recommended as the power-up sequence with the ADS54J20 in 20X mode (LMFS = 8224).



# Table 65. Initialization Sequence

STEP	SEQUENCE	DESCRIPTION	PAGE BEING PROGRAMMED	COMMENT					
1	Power-up the device	Bring up IOVDD to 1.15 V before applying power to DVDD. Bring up DVDD to 1.9 V, AVDD to 1.9 V, and AVDD3V to 3.0 V.	_	See the <i>Power Sequencing and Initialization</i> section for power sequence requirements.					
		Hardware reset							
		Apply a hardware reset by pulsing pin 48 (low $\rightarrow$ high $\rightarrow$ low).	—	A hardware reset clears all registers to their default values.					
		Register writes are equivalent to a hardware reset.							
		Write address 0-000h with 81h.	General register	Reset registers in the ADC and master pages of the analog bank.					
2	Reset the device		General register	This bit is a self-clearing bit.					
2	Reset the device	Write address 4-001h with 00h and address 4-002h with 00h.	Unused page	Clear any unwanted content from the unused pages of the JESD bank.					
		Write address 4-003h with 00h and address 4-004h with 68h.	—	Select the main digital page of the JESD bank.					
		Write address 6-0F7h with 01h for channel A.		Use the DIG RESET register bit to reset all pages in the JESD bank.					
		White address 6-0F711 with 0111 for channel A.	Main digital page (JESD bank)	This bit is a self-clearing bit.					
		Write address 6-000h with 01h, then address 6-000h with 00h.	(0200 bann)	Pulse the PULSE RESET register bit for channel A.					
		Write address 0-011h with 80h.	—	Select the master page of the analog bank.					
3	Performance modes	Write address 0-059h with 20h.	Master page (analog bank)	Set the ALWAYS WRITE 1 bit.					
		Default register writes for DDC modes and JESD link configuration (LMFS = 8224).							
		Write address 4-003h with 00h and address 4-004h with 69h.	—	Select the JESD digital page.					
		Write address 6-000h with 80h.	JESD	Set the CTRL K bit for both channels by programming K according to the SYSREF signal later on in the sequence.					
		JESD link is configured with LMFS = 8224 by default with no decimation.	digital page (JESD bank)	See Table 14 for configuring the JESD digital page registers for the desired LMFS and programming appropriate DDC mode.					
		Write address 4-003h with 00h and address 4-004h with 6Ah.	—	Select the JESD analog page.					
4	Program desired registers for decimation options and JESD link configuration	JESD link is configured with LMFS = 8224 by default with no decimation.	JESD	See Table 14 for configuring the JESD analog page registers for the desired LMFS and programming appropriate DDC mode.					
	eres mill comigaration	Write address 6-017h with 40h.	analog page (JESD bank)	PLL reset.					
		Write address 6-017h with 00h.	(0202 20)	PLL reset clear.					
		Write address 4-003h with 00h and address 4-004h with 68h.	—	Select the main digital page.					
		JESD link is configured with LMFS = 8224 by default with no decimation.	Main digital page	See Table 14 for configuring the main digital page registers for the desired LMFS and programming appropriate DDC mode.					
		Write address 6-000h with 01h and address 6-000h with 00h.	(JESD bank)	Pulse the PULSE RESET register bit. All settings programmed in the main digital page take effect only after this bit is pulsed.					

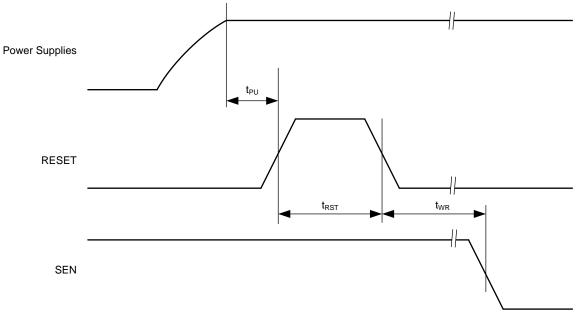
# Table 65. Initialization Sequence (continued)

STEP	SEQUENCE	DESCRIPTION	PAGE BEING PROGRAMMED	COMMENT
	Cat the value of K and the	Write address 4-003h with 00h and address 4-004h with 69h.	—	Select the JESD digital page.
5	Set the value of K and the 5 SYSREF signal frequency accordingly	Write address 6-006h with XXh (choose the value of K).	JESD digital page (JESD bank)	See the SYSREF Signal section to choose the correct frequency for SYSREF.
		Pull the SYNCB pin (pin 63) low.		Transmit K28.5 characters.
6	6 JESD lane alignment	Pull the SYNCB pin high.	_	After the receiver is synchronized, initiate an ILA phase and subsequent transmissions of ADC data.



#### 9.1.2 Hardware Reset

Figure 130 and Table 66 show the timing for a hardware reset.



# Figure 130. Hardware Reset Timing Diagram

Table 66. Timing Requirements for F	Figure 1	130
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		MIN	TYP	MAX	UNIT
t <sub>PU</sub>	Power-on delay from power-up to an active high RESET pulse	1			ms
t <sub>RST</sub>	Reset pulse duration: active high RESET pulse duration	10			ns
t <sub>WR</sub>	Register write delay from RESET disable to SEN active	100			ns

# 9.1.3 SNR and Clock Jitter

The signal-to-noise ratio (SNR) of the ADC is limited by three different factors: quantization noise, thermal noise, and jitter, as shown in Equation 4. The quantization noise is typically not noticeable in pipeline converters and is 74 dBFS for a 12-bit ADC. The thermal noise limits SNR at low input frequencies and the clock jitter sets SNR for higher input frequencies.

$$SNR_{ADC}[dBc] = -20log \sqrt{\left(10^{-\frac{SNR_{Quantization Noise}}{20}}\right)^2 + \left(10^{-\frac{SNR_{Thermal Noise}}{20}}\right)^2 + \left(10^{-\frac{SNR_{Jitter}}{20}}\right)^2}$$
(4)

The SNR limitation resulting from sample clock jitter can be calculated by Equation 5:

$$SNR_{Jitter}[dBc] = -20log(2\pi \times f_{in} \times T_{Jitter})$$
<sup>(5)</sup>

The total clock jitter ( $T_{\text{Jitter}}$ ) has two components: the internal aperture jitter (130 f<sub>S</sub>) is set by the noise of the clock input buffer and the external clock jitter.  $T_{\text{Jitter}}$  can be calculated by Equation 6:

$$T_{Jitter} = \sqrt{\left(T_{Jitter, Ext\_Clock\_Input}\right)^2 + \left(T_{Aperture\_ADC}\right)^2} \tag{6}$$

External clock jitter can be minimized by using high-quality clock sources and jitter cleaners as well as band-pass filters at the clock input. A faster clock slew rate also improves the ADC aperture jitter.

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The ADS54J20 has a thermal noise of approximately 71.1 dBFS and an internal aperture jitter of 120  $f_s$ . SNR, depending on the amount of external jitter for different input frequencies, is shown in Figure 131.

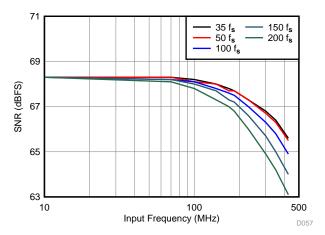
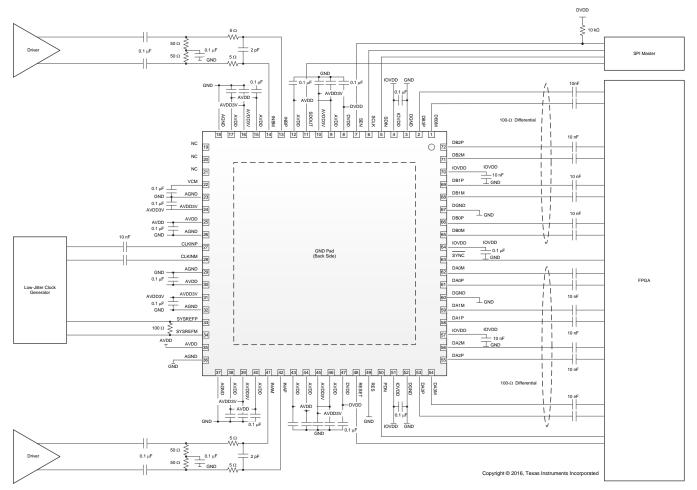


Figure 131. SNR versus Input Frequency and External Clock Jitter



### 9.2 Typical Application

The ADS54J20 is designed for wideband receiver applications demanding excellent dynamic range over a large input frequency range. A typical schematic for an ac-coupled receiver is shown in Figure 132.



NOTE: GND = AGND and DGND are connected in the PCB layout.

#### Figure 132. AC-Coupled Receiver

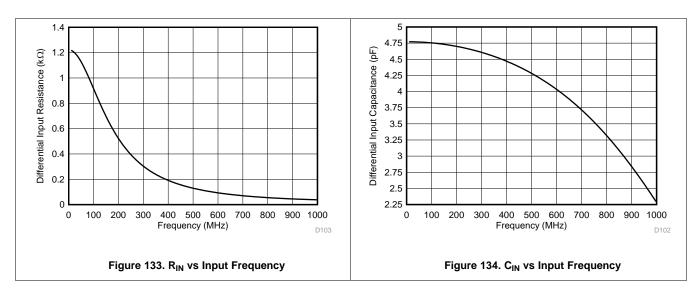


### **Typical Application (continued)**

#### 9.2.1 Design Requirements

#### 9.2.1.1 Transformer-Coupled Circuits

Typical applications involving transformer-coupled circuits are discussed in this section. Transformers (such as ADT1-1WT or WBC1-1) can be used up to 300 MHz to achieve good phase and amplitude balances at the ADC inputs. When designing dc-driving circuits, the ADC input impedance must be considered. Figure 133 and Figure 134 show the impedance ( $Z_{IN} = R_{IN} || C_{IN}$ ) across the ADC input pins.



By using the simple drive circuit of Figure 135, uniform performance can be obtained over a wide frequency range. The buffers present at the analog inputs of the device help isolate the external drive source from the switching currents of the sampling circuit.

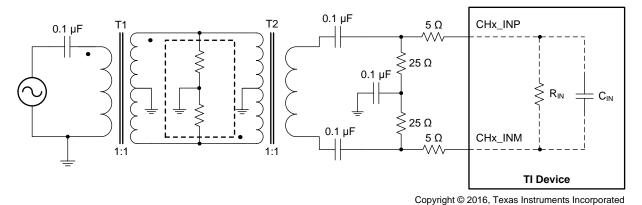


Figure 135. Input Drive Circuit

#### 9.2.2 Detailed Design Procedure

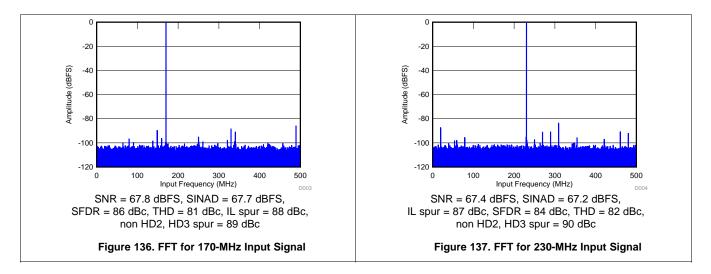
For optimum performance, the analog inputs must be driven differentially. This architecture improves commonmode noise immunity and even-order harmonic rejection. A small resistor (5  $\Omega$  to 10  $\Omega$ ) in series with each input pin is recommended to damp out ringing caused by package parasitics, as shown in Figure 135.



#### **Typical Application (continued)**

### 9.2.3 Application Curves

Figure 136 and Figure 137 show the typical performance at 170 MHz and 230 MHz, respectively.



## **10** Power Supply Recommendations

The device requires a 1.15-V nominal supply for IOVDD, a 1.9-V nominal supply for DVDD, a 1.9-V nominal supply for AVDD, and a 3.0-V nominal supply for AVDD3V. For detailed information regarding the operating voltage minimum and maximum specifications of different supplies, see the *Recommended Operating Conditions* table.

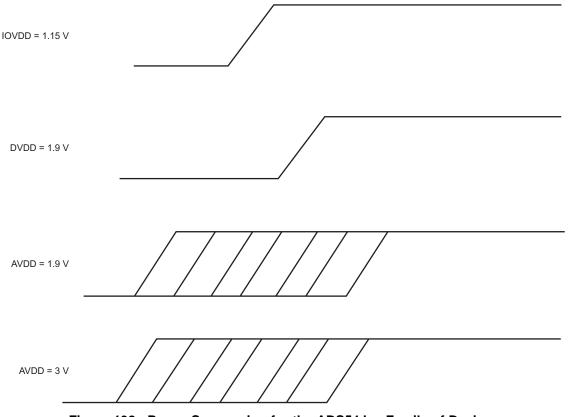
SBAS766B-MAY 2016-REVISED JANUARY 2017



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### **10.1** Power Sequencing and Initialization

Figure 138 shows the suggested power-up sequencing for the device. Note that the 1.15-V IOVDD supply must rise before the 1.9-V DVDD supply. If the 1.9-V DVDD supply rises before the 1.15-V IOVDD supply, then the internal default register settings may not load properly. The other supplies (the 3-V AVDD3V and the 1.9-V AVDD), can come up in any order during the power sequence. The power supplies can ramp up at any rate and there is no hard requirement for the time delay between IOVDD ramp up to DVDD ramp-up (can be in orders of microseconds but is recommend to be a few milliseconds).







## 11 Layout

### 11.1 Layout Guidelines

The device evaluation module (EVM) layout can be used as a reference layout to obtain the best performance. A layout diagram of the EVM top layer is provided in Figure 139. The *ADS54J20EVM User's Guide* (SLAU687), provides a complete layout of the EVM. Some important points to remember during board layout are:

- Analog inputs are located on opposite sides of the device pinout to ensure minimum crosstalk on the package level. To minimize crosstalk onboard, the analog inputs must exit the pinout in opposite directions, as illustrated in the reference layout of Figure 139 as much as possible.
- In the device pinout, the sampling clock is located on a side perpendicular to the analog inputs in order to minimize coupling between them. This configuration is also maintained on the reference layout of Figure 139 as much as possible.
- Keep digital outputs away from the analog inputs. When these digital outputs exit the pinout, the digital output
  traces must not be kept parallel to the analog input traces because this configuration can result in coupling
  from the digital outputs to the analog inputs and degrade performance. All digital output traces to the receiver
  [such as a field-programmable gate arrays (FPGAs) or application-specific integrated circuits (ASICs)] must
  be matched in length to avoid skew among outputs.
- At each power-supply pin (AVDD, DVDD, or AVDDD3V), keep a 0.1-μF decoupling capacitor close to the device. A separate decoupling capacitor group consisting of a parallel combination of 10-μF, 1-μF, and 0.1-μF capacitors can be kept close to the supply source.

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## 11.2 Layout Example

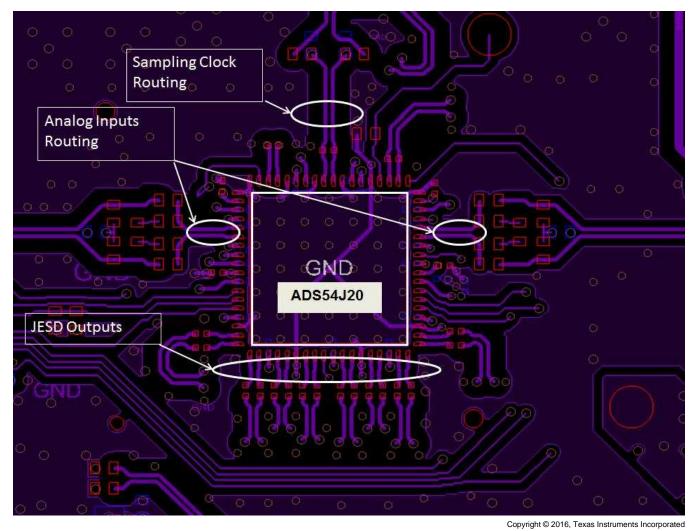


Figure 139. ADS54J20EVM Layout



## **12 Device and Documentation Support**

### **12.1** Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

- ADS54J40 Dual-Channel, 14-Bit, 1.0-GSPS Analog-to-Digital Converter
- ADS54J42 Dual-Channel, 14-Bit, 625-MSPS, Analog-to-Digital Converter
- ADS54J60 Dual-Channel, 16-Bit, 1.0-GSPS Analog-to-Digital Converter
- ADS54J66 Quad-Channel, 14-Bit, 500-MSPS ADC with Integrated DDC
- ADS54J69 Dual-Channel, 16-Bit, 500-MSPS, Analog-to-Digital Converter
- ADS54J20EVM User's Guide

#### 12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### **12.3 Community Resources**

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

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**Design Support TI's Design Support** Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 12.4 Trademarks

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#### 12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.6 Glossary

#### SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



10-Dec-2020

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
ADS54J20IRMP	ACTIVE	VQFN	RMP	72	168	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ54J20	Samples
ADS54J20IRMPT	ACTIVE	VQFN	RMP	72	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ54J20	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## PACKAGE OPTION ADDENDUM

10-Dec-2020

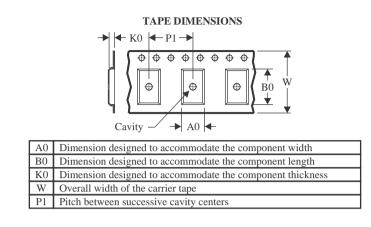


Texas

STRUMENTS

### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal
-----------------------------

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ADS54J20IRMPT	VQFN	RMP	72	250	180.0	24.4	10.25	10.25	2.25	16.0	24.0	Q2



# PACKAGE MATERIALS INFORMATION

27-Dec-2024



\*All dimensions are nominal

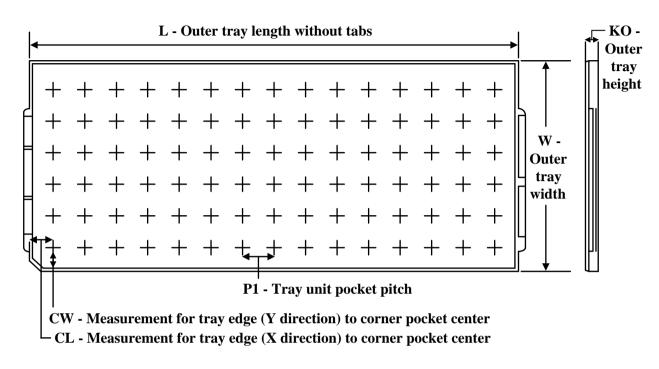
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ADS54J20IRMPT	VQFN	RMP	72	250	213.0	191.0	55.0

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## TRAY

27-Dec-2024



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW (mm)
ADS54J20IRMP	RMP	VQFNP	72	168	8 X 21	150	315	135.9	7620	14.65	11	11.95

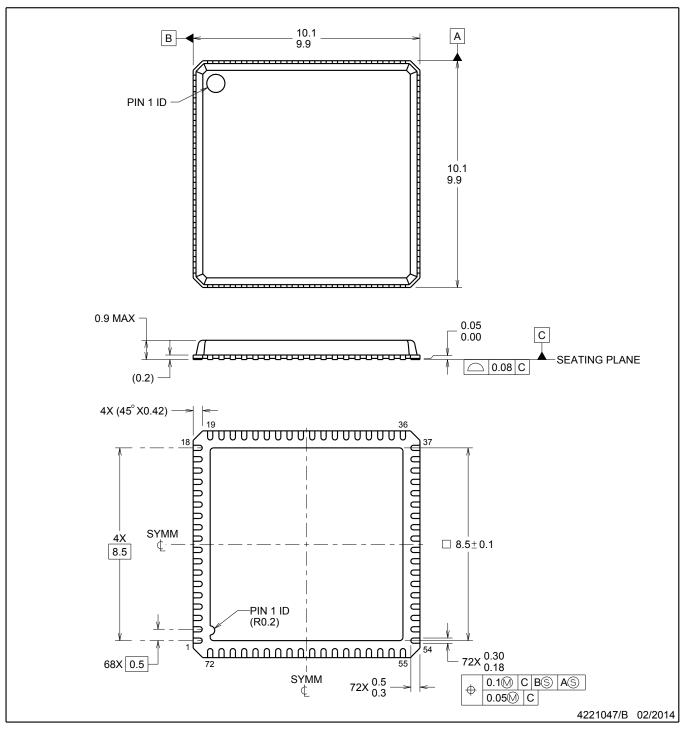
# **RMP0072A**



## **PACKAGE OUTLINE**

## VQFN - 0.9 mm max height

VQFN



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

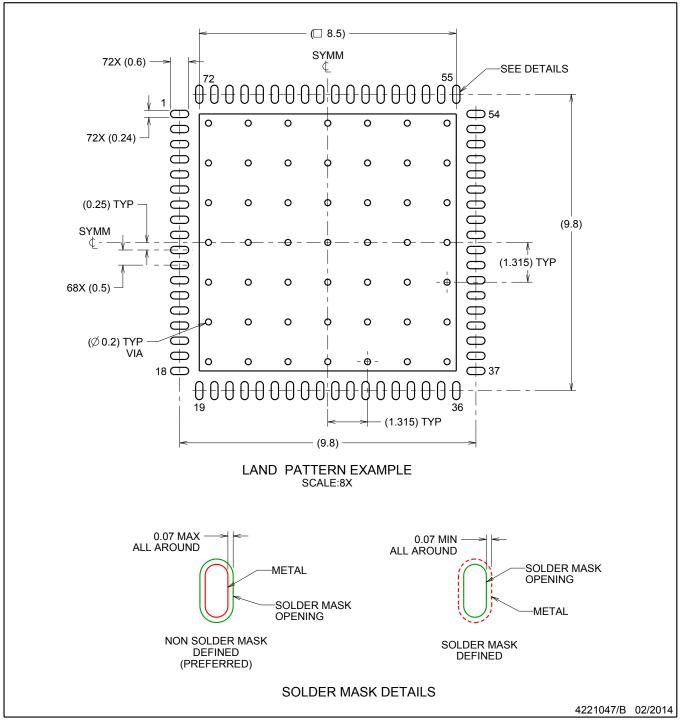


# **RMP0072A**

# **EXAMPLE BOARD LAYOUT**

## VQFN - 0.9 mm max height

VQFN



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see QFN/SON PCB application report in literature No. SLUA271 (www.ti.com/lit/slua271).

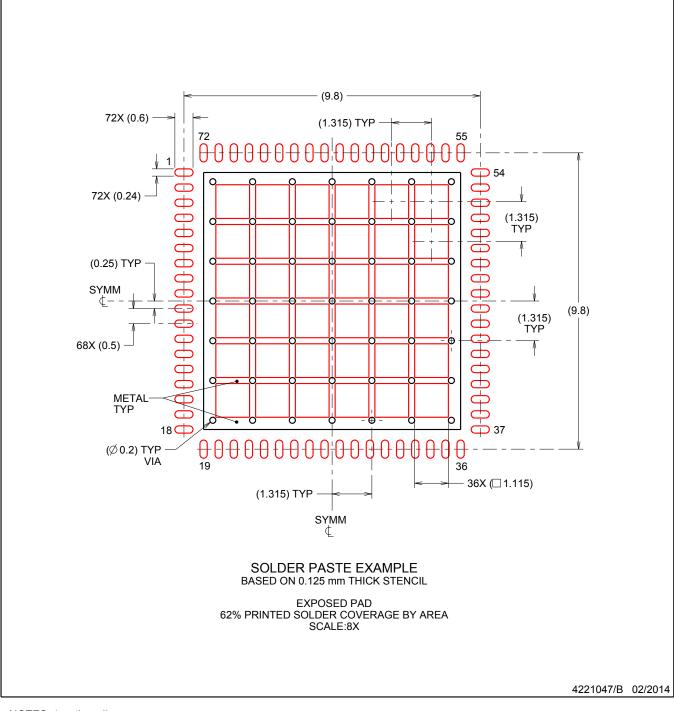


# **RMP0072A**

# **EXAMPLE STENCIL DESIGN**

## VQFN - 0.9 mm max height

VQFN



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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